The S-82D1A Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries, which includes temperature protection circuits, high-accuracy voltage detection circuits, and delay circuits. Temperature protection is possible by connecting an NTC thermistor to the dedicated connection pin. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

■ Features

- High-accuracy temperature protection circuit by an external NTC thermistor
  - High temperature charge-discharge inhibition temperature: +40°C to +85°C (1°C step) Accuracy ±3°C*1
  - High temperature charge inhibition temperature: +40°C to +85°C (1°C step) Accuracy ±3°C*1
  - Low temperature charge inhibition temperature: –40°C to +10°C (1°C step) Accuracy ±3°C*1
  - Low temperature charge-discharge inhibition temperature: –40°C to +10°C (1°C step) Accuracy ±3°C*1
- High-accuracy voltage detection circuit
  - Overcharge detection voltage: 3.500 V to 4.600 V (5 mV step) Accuracy ±15 mV
  - Overcharge release voltage: 3.100 V to 4.600 V*2 Accuracy ±50 mV
  - Overdischarge detection voltage: 2.000 V to 3.000 V (10 mV step) Accuracy ±50 mV
  - Overdischarge release voltage: 2.000 V to 3.400 V*3 Accuracy ±75 mV
  - Discharge overcurrent detection voltage 1: 0.003 V to 0.100 V (0.5 mV step) Accuracy ±1.5 mV
  - Discharge overcurrent detection voltage 2: 0.010 V to 0.100 V (1 mV step) Accuracy ±3 mV
  - Load short-circuiting detection voltage: 0.020 V to 0.100 V (1 mV step) Accuracy ±5 mV
  - Charge overcurrent detection voltage: –0.100 V to –0.003 V (0.5 mV step) Accuracy ±1.5 mV
- Detection delay times are generated only by an internal circuit (external capacitors are unnecessary).
- Charge-discharge control function
  - CTL pin control logic: Active "H", active "L"
  - CTL pin internal resistance: Pull-up, pull-down
  - CTL pin internal resistance value: 1 MΩ to 5 MΩ (1 MΩ step)
- Discharge overcurrent control function
  - Release condition of discharge overcurrent status: Load disconnection
  - Release voltage of discharge overcurrent status: Discharge overcurrent release voltage (V_{RIOV}) = $V_{DD} \times 0.8$ (typ.)
- Discharge overcurrent status reset function by CTL pin: Available, unavailable
- 0 V battery charge: Enabled, inhibited
- Power-down function: Available, unavailable
- High-withstand voltage: VM pin and CO pin: Absolute maximum rating 28.0 V
- Wide operation temperature range: Ta = –40°C to +85°C
- Low current consumption
  - During operation: 2.5 µA typ., 5.0 µA max. (Ta = +25°C)
  - During power-down: 100 nA max. (Ta = +25°C)
  - During overdischarge: 0.5 µA max. (Ta = +25°C)
- Lead-free (Sn 100%), halogen-free

***1.** Temperature detection accuracy varies with NTC thermistor specifications.
When an NTC thermistor listed in **Table 6** is connected, the detection temperature and accuracy can be achieved.
***2.** Overcharge release voltage = Overcharge detection voltage – Overcharge hysteresis voltage
(Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)
***3.** Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage
(Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)

■ Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

■ Package

- HSNT-8(1616)

■ Block Diagram

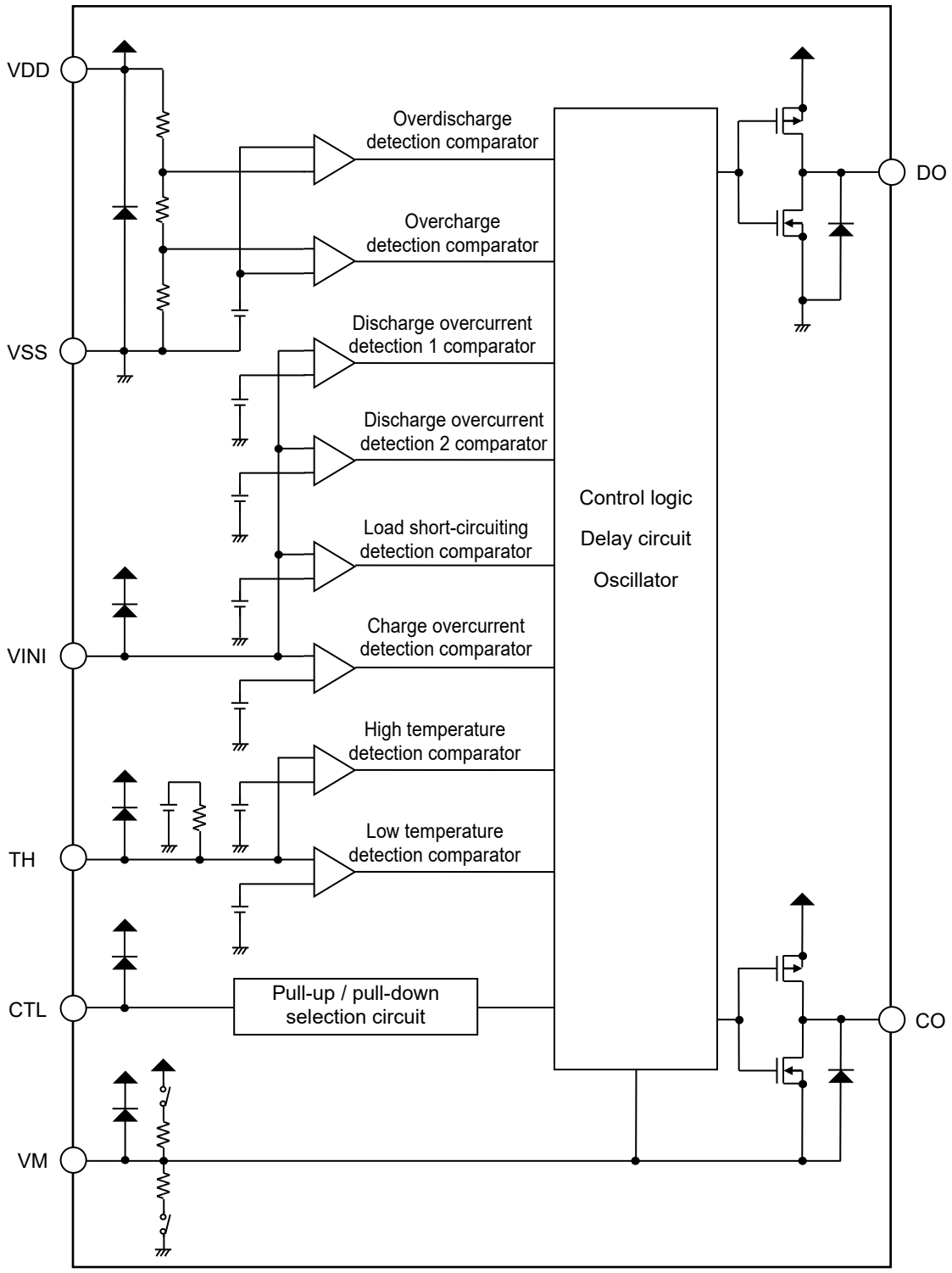
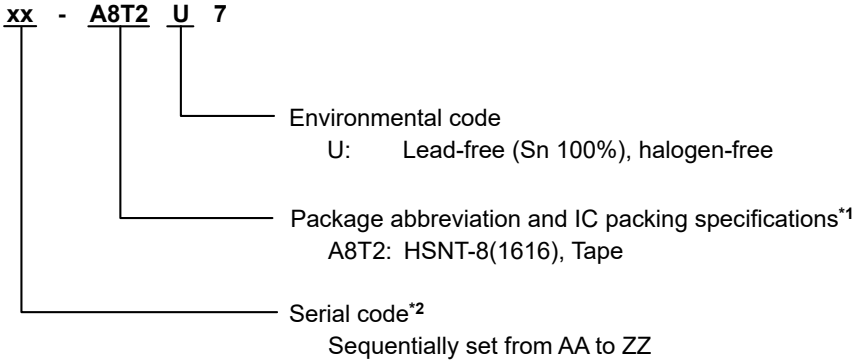


Figure 1

■ Product Name Structure

1. Product name

S-82D1A xx - A8T2 U 7



***1.** Refer to the tape drawing.
***2.** Refer to "**3. Product name list**".

2. Package

Table 1 Package Drawing Codes

Package Name	Dimension	Tape	Reel	Land
HSNT-8(1616)	PY008-A-P-SD	PY008-A-C-SD	PY008-A-R-SD	PY008-A-L-SD

3. Product name list

Table 2 (1 / 2)

Product Name	Overcharge Detection Voltage [V_{CU}]	Overcharge Release Voltage [V_{CL}]	Overdischarge Detection Voltage [V_{DL}]	Overdischarge Release Voltage [V_{DU}]	Discharge Overcurrent Detection Voltage 1 [V_{DIOV1}]	Discharge Overcurrent Detection Voltage 2 [V_{DIOV2}]	Load Short-circuiting Detection Voltage [V_{SHORT}]	Charge Overcurrent Detection Voltage [V_{CIOV}]
S-82D1AAA-A8T2U7	4.475 V	4.275 V	2.500 V	2.900 V	0.0150 V	–	0.040 V	–0.0150 V
S-82D1AAB-A8T2U7	4.425 V	4.225 V	2.300 V	2.500 V	0.0105 V	0.015 V	0.030 V	–0.0105 V
S-82D1AAD-A8T2U7	4.280 V	4.080 V	3.000 V	3.400 V	0.0300 V	–	0.050 V	–0.0300 V
S-82D1AAE-A8T2U7	4.500 V	4.300 V	2.500 V	2.900 V	0.0270 V	–	0.054 V	–0.0210 V
S-82D1AAI-A8T2U7	4.250 V	4.250 V	2.800 V	3.000 V	0.0150 V	–	0.040 V	–0.0150 V
S-82D1AAJ-A8T2U7	4.400 V	4.400 V	2.800 V	3.000 V	0.0150 V	–	0.040 V	–0.0150 V
S-82D1AAK-A8T2U7	4.450 V	4.450 V	2.800 V	3.000 V	0.0150 V	–	0.040 V	–0.0150 V
S-82D1AAL-A8T2U7	4.500 V	4.500 V	2.800 V	3.000 V	0.0150 V	–	0.040 V	–0.0150 V
S-82D1AAM-A8T2U7	4.260 V	4.260 V	3.120 V	3.320 V	0.0480 V	0.060 V	0.090 V	–0.0380 V
S-82D1AAN-A8T2U7	4.550 V	4.350 V	2.000 V	2.100 V	0.0500 V	–	0.100 V	–0.0500 V
S-82D1AAO-A8T2U7	4.250 V	4.150 V	2.800 V	3.000 V	0.0200 V	–	0.040 V	–0.1000 V
S-82D1AAP-A8T2U7	4.100 V	3.700 V	2.800 V	3.000 V	0.0400 V	–	0.100 V	–0.0120 V
S-82D1AAQ-A8T2U7	4.180 V	3.980 V	2.480 V	2.880 V	0.0250 V	–	0.060 V	–0.0050 V

Table 2 (2 / 2)

Product Name	Delay Time Combination*1	CTL Pin Combination*2	0 V Battery Charge*3	Power-down Function*4
S-82D1AAA-A8T2U7	(1)	(1)	Inhibited	Unavailable
S-82D1AAB-A8T2U7	(2)	(1)	Enabled	Unavailable
S-82D1AAD-A8T2U7	(1)	(1)	Enabled	Available
S-82D1AAE-A8T2U7	(1)	(1)	Inhibited	Unavailable
S-82D1AAI-A8T2U7	(6)	(1)	Enabled	Available
S-82D1AAJ-A8T2U7	(6)	(1)	Enabled	Available
S-82D1AAK-A8T2U7	(6)	(1)	Enabled	Available
S-82D1AAL-A8T2U7	(6)	(1)	Enabled	Available
S-82D1AAM-A8T2U7	(5)	(2)	Inhibited	Available
S-82D1AAN-A8T2U7	(3)	(1)	Enabled	Unavailable
S-82D1AAO-A8T2U7	(7)	(1)	Inhibited	Available
S-82D1AAP-A8T2U7	(8)	(1)	Inhibited	Available
S-82D1AAQ-A8T2U7	(9)	(3)	Enabled	Available

***1.** Refer to **Table 3** about the details of the delay time combinations.
***2.** Refer to **Table 5** about the details of the CTL pin combinations.
***3.** 0 V battery charge: Enabled, inhibited
***4.** Power-down function: Available, unavailable

Remark Please contact our sales representatives for products other than the above.

Table 3

Delay Time Combination	Overcharge Detection Delay Time [t_{CU}]	Overdischarge Detection Delay Time [t_{DL}]	Discharge Overcurrent Detection Delay Time 1 [t_{DIOV1}]	Discharge Overcurrent Detection Delay Time 2 [t_{DIOV2}]	Load Short-circuiting Detection Delay Time [t_{SHORT}]	Charge Overcurrent Detection Delay Time [t_{CIOV}]	Charge-discharge Inhibition Delay Time [t_{CTL}]
(1)	1.0 s	64 ms	32 ms	–	280 µs	16 ms	48 ms
(2)	1.0 s	64 ms	3750 ms	16 ms	280 µs	16 ms	48 ms
(3)	1.0 s	128 ms	1.0 s	–	530 µs	128 ms	64 ms
(4)	256 ms	64 ms	32 ms	–	280 µs	16 ms	48 ms
(5)	1.0 s	128 ms	512 ms	128 ms	530 µs	128 ms	32 ms
(6)	1.0 s	128 ms	16 ms	–	280 µs	16 ms	48 ms
(7)	1.0 s	128 ms	8 ms	–	280 µs	8 ms	32 ms
(8)	1.0 s	64 ms	64 ms	–	280 µs	8 ms	48 ms
(9)	1.0 s	128 ms	128 ms	–	280 µs	16 ms	48 ms

Remark The delay times can be changed within the range listed in **Table 4**. For details, please contact our sales representatives.

Table 4

Delay Time	Symbol	Selection Range						Remark
Overcharge detection delay time	t_{CU}	256 ms	512 ms	1.0 s	–	–	–	Select a value from the left.
Overdischarge detection delay time	t_{DL}	32 ms	64 ms	128 ms	–	–	–	Select a value from the left.
Discharge overcurrent detection delay time 1	t_{DIOV1}	8 ms	16 ms	32 ms	64 ms	128 ms	256 ms	Select a value from the left.
		512 ms	1.0 s	2.0 s	3.0 s	3.75 s	4.0 s	
Discharge overcurrent detection delay time 2	t_{DIOV2}	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.
Load short-circuiting detection delay time	t_{SHORT}	280 µs	530 µs	–	–	–	–	Select a value from the left.
Charge overcurrent detection delay time	t_{CIOV}	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.
Charge-discharge inhibition delay time	t_{CTL}	2 ms	4 ms	48 ms	64 ms	128 ms	256 ms	Select a value from the left.

Table 5

CTL Pin Combination	Control Logic*1	Internal Resistance*2	Internal Resistance Value*3 [R_{CTL}]	CTL Pin Voltage "H"*4 [V_{CTLH}]	CTL Pin Voltage "L"*5 [V_{CTLL}]
(1)	Active "H"	Pull-down	5.0 MΩ	V_{DD} – 0.9 V	V_{SS} + 0.6 V
(2)	Active "L"	Pull-up	10.0 MΩ	V_{DD} – 0.9 V	V_{SS} + 0.6 V
(3)	Active "L"	Pull-up	5.0 MΩ	V_{DD} – 0.9 V	V_{SS} + 0.6 V

***1.** CTL pin control logic: Active "H", active "L"
***2.** CTL pin internal resistance: Pull-up, pull-down
***3.** CTL pin internal resistance value: 1 MΩ to 5 MΩ (1 MΩ step)
***4.** CTL pin voltage "H": V_{SS} + 0.65 V, V_{DD} – 0.9 V
***5.** CTL pin voltage "L": V_{SS} + 0.60 V, V_{DD} – 0.9 V

Remark Please contact our sales representatives for products with CTL pin combinations other than the above.

Table 6

Product Name	High Temperature Charge-discharge Inhibition Temperature [T_{HCD}]	High Temperature Charge Inhibition Temperature [T_{HC}]	Low Temperature Charge Inhibition Temperature [T_{LC}]	Low Temperature Charge-discharge Inhibition Temperature [T_{LCD}]	Hysteresis Temperature*1 [T_{HYS}]	Sampling Wait Time*2 [t_{SLEEP}]	Continuous Detection / Release Count*3 [N]	Resistance*4 [R_{NTC}]	B-value*4 [B]
S-82D1AAA-A8T2U7	–	63°C	−3°C	–	5°C	512 ms	2	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAB-A8T2U7	82°C	63°C	−3°C	−37°C	10°C	512 ms	2	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAD-A8T2U7	42°C	–	–	−7°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAE-A8T2U7	60°C	45°C	0°C	−20°C	5°C	512 ms	2	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAI-A8T2U7	60°C	45°C	0°C	−20°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAJ-A8T2U7	60°C	45°C	0°C	−20°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAK-A8T2U7	60°C	45°C	0°C	−20°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAL-A8T2U7	60°C	45°C	0°C	−20°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAM-A8T2U7	43°C	–	–	2°C	5°C	512 ms	2	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAN-A8T2U7	82°C	49°C	−3°C	−37°C	5°C	1.0 s	5	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAO-A8T2U7	65°C	50°C	−5°C	−25°C	5°C	512 ms	2	100 kΩ ± 1%	4250 K ± 1%
S-82D1AAP-A8T2U7	60°C	50°C	0°C	−20°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%
S-82D1AAQ-A8T2U7	75°C	–	–	−35°C	5°C	512 ms	2	10 kΩ ± 1%	3380 K ± 1%

***1.** Hysteresis Temperature: 5°C, 10°C

***2.** Sampling wait time: 256 ms, 512 ms, 1.0 s

***3.** Continuous detection / release count: 1, 2, 3, 4, 5, 6

***4.** Temperature detection accuracy varies with NTC thermistor specifications.
When an NTC thermistor listed in **Table 6** is connected, the detection temperature and accuracy can be achieved.

■ Pin Configuration

1. HSNT-8(1616)

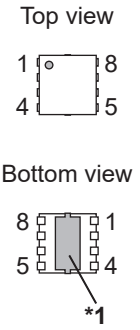


Figure 2

Table 7

Pin No.	Symbol	Description
1	CTL	Input pin for charge-discharge control signal
2	VM	Input pin for external negative voltage
3	CO	Connection pin of charge control FET gate (CMOS output)
4	DO	Connection pin of discharge control FET gate (CMOS output)
5	VSS	Input pin for negative power supply
6	VDD	Input pin for positive power supply
7	VINI	Overcurrent detection pin
8	TH	Thermistor connection pin

***1.** Connect the heat sink of backside at shadowed area to the board, and set electric potential open or V_{DD}. However, do not use it as the function of electrode.

■ Absolute Maximum Ratings

Table 8

(Ta = +25°C unless otherwise specified)

Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	V_{DS}	VDD	V_{SS} – 0.3 to V_{SS} + 6.0	V
VINI pin input voltage	V_{VINI}	VINI	V_{DD} – 6.0 to V_{DD} + 0.3	V
CTL pin input voltage	V_{CTL}	CTL	V_{DD} – 6.0 to V_{DD} + 0.3	V
VM pin input voltage	V_{VM}	VM	V_{DD} – 28.0 to V_{DD} + 0.3	V
TH pin input voltage	V_{TH}	TH	V_{DD} – 6.0 to V_{DD} + 0.3	V
DO pin output voltage	V_{DO}	DO	V_{SS} – 0.3 to V_{DD} + 0.3	V
CO pin output voltage	V_{CO}	CO	V_{VM} – 0.3 to V_{DD} + 0.3	V
Operation ambient temperature	T_{opr}	–	–40 to +85	°C
Storage temperature	T_{stg}	–	–55 to +125	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 9

Item	Symbol	Condition		Min.	Typ.	Max.	Unit
Junction-to-ambient thermal resistance*1	θ_{JA}	HSNT-8(1616)	Board A	–	214	–	°C/W
			Board B	–	172	–	°C/W
			Board C	–	–	–	°C/W
			Board D	–	–	–	°C/W
			Board E	–	–	–	°C/W

***1.** Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ **Power Dissipation**" and "**Test Board**" for details.

■ Electrical Characteristics

1. Ta = +25°C

Table 10

(Ta = +25°C unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	V_{CU}	–	$V_{CU}-0.015$	V_{CU}	$V_{CU}+0.015$	V	1
Overcharge release voltage	V_{CL}	$V_{CL} \neq V_{CU}$	$V_{CL}-0.050$	V_{CL}	$V_{CL}+0.050$	V	1
		$V_{CL} = V_{CU}$	$V_{CL}-0.020$	V_{CL}	$V_{CL}+0.015$	V	1
Overdischarge detection voltage	V_{DL}	–	$V_{DL}-0.050$	V_{DL}	$V_{DL}+0.050$	V	1
Overdischarge release voltage	V_{DU}	$V_{DL} \neq V_{DU}$	$V_{DU}-0.075$	V_{DU}	$V_{DU}+0.075$	V	2
		$V_{DL} = V_{DU}$	$V_{DU}-0.050$	V_{DU}	$V_{DU}+0.050$	V	2
Discharge overcurrent detection voltage 1	V_{DIOV1}	–	$V_{DIOV1}-0.0015$	V_{DIOV1}	$V_{DIOV1}+0.0015$	V	2
Discharge overcurrent detection voltage 2	V_{DIOV2}	–	$V_{DIOV2}-0.003$	V_{DIOV2}	$V_{DIOV2}+0.003$	V	2
Load short-circuiting detection voltage	V_{SHORT}	–	$V_{SHORT}-0.005$	V_{SHORT}	$V_{SHORT}+0.005$	V	5
Load short-circuiting detection voltage 2	V_{SHORT2}	–	$V_{DD}-1.2$	$V_{DD}-0.8$	$V_{DD}-0.5$	V	2
Charge overcurrent detection voltage	V_{CIOV}	–	$V_{CIOV}-0.0015$	V_{CIOV}	$V_{CIOV}+0.0015$	V	2
Discharge overcurrent release voltage	V_{RIOV}	V_{DD} = 3.4 V	$V_{DD}\times0.77$	$V_{DD}\times0.80$	$V_{DD}\times0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger voltage	V_{0CHA}	0 V battery charge enabled	0.7	1.1	1.5	V	4
0 V battery charge inhibition battery voltage	V_{0INH}	0 V battery charge inhibited	0.9	1.2	1.5	V	2
Internal Resistance							
Resistance between VDD pin and VM pin	R_{VMD}	V_{DD} = 1.8 V, V_{VM} = 0 V	500	1250	2500	kΩ	3
Resistance between VM pin and VSS pin	R_{VMS}	V_{DD} = 3.4 V, V_{VM} = 1.0 V	5	10	15	kΩ	3
CTL pin internal resistance	R_{CTL}	–	$R_{CTL}\times0.5$	R_{CTL}	$R_{CTL}\times2.0$	MΩ	3
Input Voltage							
Operation voltage between VDD pin and VSS pin	V_{DSOP1}	–	1.5	–	6.0	V	–
Operation voltage between VDD pin and VM pin	V_{DSOP2}	–	1.5	–	28.0	V	–
CTL pin voltage "H"	V_{CTLH}	–	$V_{CTLH}-0.2$	V_{CTLH}	$V_{CTLH}+0.2$	V	–
CTL pin voltage "L"	V_{CTLL}	–	$V_{CTLL}-0.2$	V_{CTLL}	$V_{CTLL}+0.2$	V	–
Input Current							
Current consumption during operation	I_{OPE}	V_{DD} = 3.4 V, V_{VM} = 0 V	–	2.5	5.0	μA	3
Current consumption during power-down	I_{PDN}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	0.1	μA	3
Current consumption during overdischarge	I_{OPED}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	0.5	μA	3
Output Resistance							
CO pin resistance "H"	R_{COH}	–	5	10	20	kΩ	4
CO pin resistance "L"	R_{COL}	–	5	10	20	kΩ	4
DO pin resistance "H"	R_{DOH}	–	5	10	20	kΩ	4
DO pin resistance "L"	R_{DOL}	–	1	2	4	kΩ	4
Delay Time							
Overcharge detection delay time	t_{CU}	–	$t_{CU}\times0.7$	t_{CU}	$t_{CU}\times1.3$	–	5
Overdischarge detection delay time	t_{DL}	–	$t_{DL}\times0.7$	t_{DL}	$t_{DL}\times1.3$	–	5
Discharge overcurrent detection delay time 1	t_{DIOV1}	–	$t_{DIOV1}\times0.75$	t_{DIOV1}	$t_{DIOV1}\times1.25$	–	5
Discharge overcurrent detection delay time 2	t_{DIOV2}	–	$t_{DIOV2}\times0.7$	t_{DIOV2}	$t_{DIOV2}\times1.3$	–	5
Load short-circuiting detection delay time	t_{SHORT}	–	$t_{SHORT}\times0.7$	t_{SHORT}	$t_{SHORT}\times1.3$	–	5
Charge overcurrent detection delay time	t_{CIOV}	–	$t_{CIOV}\times0.7$	t_{CIOV}	$t_{CIOV}\times1.3$	–	5
Charge-discharge inhibition delay time	t_{CTL}	–	$t_{CTL}\times0.7$	t_{CTL}	$t_{CTL}\times1.3$	–	5
Sampling wait time	t_{SLEEP}	–	$t_{SLEEP}\times0.7$	t_{SLEEP}	$t_{SLEEP}\times1.3$	–	6

2. Ta = –20°C to +60°C*1

Table 11

(Ta = –20°C to +60°C*1 unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	V_{CU}	–	$V_{CU}-0.020$	V_{CU}	$V_{CU}+0.020$	V	1
Overcharge release voltage	V_{CL}	$V_{CL} \neq V_{CU}$	$V_{CL}-0.065$	V_{CL}	$V_{CL}+0.057$	V	1
		$V_{CL} = V_{CU}$	$V_{CL}-0.025$	V_{CL}	$V_{CL}+0.020$	V	1
Overdischarge detection voltage	V_{DL}	–	$V_{DL}-0.060$	V_{DL}	$V_{DL}+0.055$	V	1
Overdischarge release voltage	V_{DU}	$V_{DL} \neq V_{DU}$	$V_{DU}-0.085$	V_{DU}	$V_{DU}+0.080$	V	2
		$V_{DL} = V_{DU}$	$V_{DU}-0.060$	V_{DU}	$V_{DU}+0.055$	V	2
Discharge overcurrent detection voltage 1	V_{DIOV1}	–	$V_{DIOV1}-0.002$	V_{DIOV1}	$V_{DIOV1}+0.002$	V	2
Discharge overcurrent detection voltage 2	V_{DIOV2}	–	$V_{DIOV2}-0.003$	V_{DIOV2}	$V_{DIOV2}+0.003$	V	2
Load short-circuiting detection voltage	V_{SHORT}	–	$V_{SHORT}-0.005$	V_{SHORT}	$V_{SHORT}+0.005$	V	5
Load short-circuiting detection voltage 2	V_{SHORT2}	–	$V_{DD}-1.4$	$V_{DD}-0.8$	$V_{DD}-0.3$	V	2
Charge overcurrent detection voltage	V_{CIOV}	–	$V_{CIOV}-0.002$	V_{CIOV}	$V_{CIOV}+0.002$	V	2
Discharge overcurrent release voltage	V_{RIOV}	V_{DD} = 3.4 V	$V_{DD} \times 0.77$	$V_{DD} \times 0.80$	$V_{DD} \times 0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger voltage	V_{0CHA}	0 V battery charge enabled	0.5	1.1	1.7	V	4
0 V battery charge inhibition battery voltage	V_{0INH}	0 V battery charge inhibited	0.7	1.2	1.7	V	2
Internal Resistance							
Resistance between VDD pin and VM pin	R_{VMD}	V_{DD} = 1.8 V, V_{VM} = 0 V	250	1250	3500	kΩ	3
Resistance between VM pin and VSS pin	R_{VMS}	V_{DD} = 3.4 V, V_{VM} = 1.0 V	3.5	10	20	kΩ	3
CTL pin internal resistance	R_{CTL}	–	$R_{CTL} \times 0.25$	R_{CTL}	$R_{CTL} \times 3.0$	MΩ	3
Input Voltage							
Operation voltage between VDD pin and VSS pin	V_{DSOP1}	–	1.5	–	6.0	V	–
Operation voltage between VDD pin and VM pin	V_{DSOP2}	–	1.5	–	28.0	V	–
CTL pin voltage "H"	V_{CTLH}	–	$V_{CTLH}-0.3$	V_{CTLH}	$V_{CTLH}+0.3$	V	–
CTL pin voltage "L"	V_{CTLL}	–	$V_{CTLL}-0.3$	V_{CTLL}	$V_{CTLL}+0.3$	V	–
Input Current							
Current consumption during operation	I_{OPE}	V_{DD} = 3.4 V, V_{VM} = 0 V	–	2.5	6.0	μA	3
Current consumption during power-down	I_{PDN}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	0.15	μA	3
Current consumption during overdischarge	I_{OPED}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	1.0	μA	3
Output Resistance							
CO pin resistance "H"	R_{COH}	–	2.5	10	30	kΩ	4
CO pin resistance "L"	R_{COL}	–	2.5	10	30	kΩ	4
DO pin resistance "H"	R_{DOH}	–	2.5	10	30	kΩ	4
DO pin resistance "L"	R_{DOL}	–	0.5	2	6	kΩ	4
Delay Time							
Overcharge detection delay time	t_{CU}	–	$t_{CU} \times 0.6$	t_{CU}	$t_{CU} \times 1.4$	–	5
Overdischarge detection delay time	t_{DL}	–	$t_{DL} \times 0.6$	t_{DL}	$t_{DL} \times 1.4$	–	5
Discharge overcurrent detection delay time 1	t_{DIOV1}	–	$t_{DIOV1} \times 0.65$	t_{DIOV1}	$t_{DIOV1} \times 1.35$	–	5
Discharge overcurrent detection delay time 2	t_{DIOV2}	–	$t_{DIOV2} \times 0.6$	t_{DIOV2}	$t_{DIOV2} \times 1.4$	–	5
Load short-circuiting detection delay time	t_{SHORT}	–	$t_{SHORT} \times 0.6$	t_{SHORT}	$t_{SHORT} \times 1.4$	–	5
Charge overcurrent detection delay time	t_{CIOV}	–	$t_{CIOV} \times 0.6$	t_{CIOV}	$t_{CIOV} \times 1.4$	–	5
Charge-discharge inhibition delay time	t_{CTL}	–	$t_{CTL} \times 0.6$	t_{CTL}	$t_{CTL} \times 1.4$	–	5
Sampling wait time	t_{SLEEP}	–	$t_{SLEEP} \times 0.6$	t_{SLEEP}	$t_{SLEEP} \times 1.4$	–	6

***1.** Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

3. Ta = –40°C to +85°C*1

Table 12

(Ta = –40°C to +85°C*1 unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Test Circuit
Detection Voltage							
Overcharge detection voltage	V_{CU}	–	$V_{CU}-0.045$	V_{CU}	$V_{CU}+0.030$	V	1
Overcharge release voltage	V_{CL}	$V_{CL} \neq V_{CU}$	$V_{CL}-0.080$	V_{CL}	$V_{CL}+0.060$	V	1
		$V_{CL} = V_{CU}$	$V_{CL}-0.050$	V_{CL}	$V_{CL}+0.030$	V	1
Overdischarge detection voltage	V_{DL}	–	$V_{DL}-0.080$	V_{DL}	$V_{DL}+0.060$	V	1
Overdischarge release voltage	V_{DU}	$V_{DL} \neq V_{DU}$	$V_{DU}-0.105$	V_{DU}	$V_{DU}+0.085$	V	2
		$V_{DL} = V_{DU}$	$V_{DU}-0.080$	V_{DU}	$V_{DU}+0.060$	V	2
Discharge overcurrent detection voltage 1	V_{DIOV1}	–	$V_{DIOV1}-0.002$	V_{DIOV1}	$V_{DIOV1}+0.002$	V	2
Discharge overcurrent detection voltage 2	V_{DIOV2}	–	$V_{DIOV2}-0.003$	V_{DIOV2}	$V_{DIOV2}+0.003$	V	2
Load short-circuiting detection voltage	V_{SHORT}	–	$V_{SHORT}-0.005$	V_{SHORT}	$V_{SHORT}+0.005$	V	5
Load short-circuiting detection voltage 2	V_{SHORT2}	–	$V_{DD}-1.4$	$V_{DD}-0.8$	$V_{DD}-0.3$	V	2
Charge overcurrent detection voltage	V_{CIOV}	–	$V_{CIOV}-0.002$	V_{CIOV}	$V_{CIOV}+0.002$	V	2
Discharge overcurrent release voltage	V_{RIOV}	V_{DD} = 3.4 V	$V_{DD}\times0.77$	$V_{DD}\times0.80$	$V_{DD}\times0.83$	V	2
0 V Battery Charge							
0 V battery charge starting charger voltage	V_{0CHA}	0 V battery charge enabled	0.5	1.1	1.7	V	4
0 V battery charge inhibition battery voltage	V_{0INH}	0 V battery charge inhibited	0.7	1.2	1.7	V	2
Internal Resistance							
Resistance between VDD pin and VM pin	R_{VMD}	V_{DD} = 1.8 V, V_{VM} = 0 V	250	1250	3500	kΩ	3
Resistance between VM pin and VSS pin	R_{VMS}	V_{DD} = 3.4 V, V_{VM} = 1.0 V	3.5	10	20	kΩ	3
CTL pin internal resistance	R_{CTL}	–	$R_{CTL}\times0.25$	R_{CTL}	$R_{CTL}\times3.0$	MΩ	3
Input Voltage							
Operation voltage between VDD pin and VSS pin	V_{DSOP1}	–	1.5	–	6.0	V	–
Operation voltage between VDD pin and VM pin	V_{DSOP2}	–	1.5	–	28.0	V	–
CTL pin voltage "H"	V_{CTLH}	–	$V_{CTLH}-0.3$	V_{CTLH}	$V_{CTLH}+0.3$	V	–
CTL pin voltage "L"	V_{CTLL}	–	$V_{CTLL}-0.3$	V_{CTLL}	$V_{CTLL}+0.3$	V	–
Input Current							
Current consumption during operation	I_{OPE}	V_{DD} = 3.4 V, V_{VM} = 0 V	–	2.5	6.0	μA	3
Current consumption during power-down	I_{PDN}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	0.15	μA	3
Current consumption during overdischarge	I_{OPED}	$V_{DD} = V_{VM}$ = 1.5 V	–	–	1.0	μA	3
Output Resistance							
CO pin resistance "H"	R_{COH}	–	2.5	10	30	kΩ	4
CO pin resistance "L"	R_{COL}	–	2.5	10	30	kΩ	4
DO pin resistance "H"	R_{DOH}	–	2.5	10	30	kΩ	4
DO pin resistance "L"	R_{DOL}	–	0.5	2	6	kΩ	4
Delay Time							
Overcharge detection delay time	t_{CU}	–	$t_{CU}\times0.4$	t_{CU}	$t_{CU}\times1.6$	–	5
Overdischarge detection delay time	t_{DL}	–	$t_{DL}\times0.4$	t_{DL}	$t_{DL}\times1.6$	–	5
Discharge overcurrent detection delay time 1	t_{DIOV1}	–	$t_{DIOV1}\times0.4$	t_{DIOV1}	$t_{DIOV1}\times1.6$	–	5
Discharge overcurrent detection delay time 2	t_{DIOV2}	–	$t_{DIOV2}\times0.4$	t_{DIOV2}	$t_{DIOV2}\times1.6$	–	5
Load short-circuiting detection delay time	t_{SHORT}	–	$t_{SHORT}\times0.4$	t_{SHORT}	$t_{SHORT}\times1.6$	–	5
Charge overcurrent detection delay time	t_{CIOV}	–	$t_{CIOV}\times0.4$	t_{CIOV}	$t_{CIOV}\times1.6$	–	5
Charge-discharge inhibition delay time	t_{CTL}	–	$t_{CTL}\times0.4$	t_{CTL}	$t_{CTL}\times1.6$	–	5
Sampling wait time	t_{SLEEP}	–	$t_{SLEEP}\times0.4$	t_{SLEEP}	$t_{SLEEP}\times1.6$	–	6

***1.** Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

4. High-accuracy temperature protection circuit by an external NTC thermistor

Table 13

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Test Circuit
High temperature charge-discharge inhibition temperature	T_{HCD}	–	$T_{HCD} - 3$	T_{HCD}	$T_{HCD} + 3$	°C	6
High temperature charge inhibition temperature	T_{HC}	–	$T_{HC} - 3$	T_{HC}	$T_{HC} + 3$	°C	6
Low temperature charge inhibition temperature	T_{LC}	–	$T_{LC} - 3$	T_{LC}	$T_{LC} + 3$	°C	6
Low temperature charge-discharge inhibition temperature	T_{LCD}	–	$T_{LCD} - 3$	T_{LCD}	$T_{LCD} + 3$	°C	6
Hysteresis temperature	T_{HYS}	–	$T_{HYS} - 2$	T_{HYS}	$T_{HYS} + 2$	°C	6
Continuous detection / release count	N	–	–	N	–	–	6

■ Test Circuits

When CTL pin control logic is active "H", SW1 and SW3 are turned off, SW2 and SW4 are turned on. When CTL pin control logic is active "L", SW1 and SW3 are turned on, SW2 and SW4 are turned off.

For R5 in " **Figure 8 Test Circuit 6**", make sure to use a resistor with the same resistance as R_{NTC} in **Table 6**.

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin (V_{CO}) and DO pin (V_{DO}) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to V_{VM} and the DO pin level with respect to V_{SS}.

1. Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage (V_{CU}) is defined as the voltage V1 at which V_{CO} goes from "H" to "L" when the voltage V1 is gradually increased after setting V1 = 3.4 V, V7 = 0.25 V. Overcharge release voltage (V_{CL}) is defined as the voltage V1 at which V_{CO} goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage (V_{HC}) is defined as the difference between V_{CU} and V_{CL}.

2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage (V_{DL}) is defined as the voltage V1 at which V_{DO} goes from "H" to "L" when the voltage V1 is gradually decreased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V. Overdischarge release voltage (V_{DU}) is defined as the voltage V1 at which V_{DO} goes from "L" to "H" when setting V2 = 0.01 V, V5 = V6 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage (V_{HD}) is defined as the difference between V_{DU} and V_{DL}.

3. Discharge overcurrent detection voltage 1, discharge overcurrent release voltage (Test circuit 5)

Discharge overcurrent detection voltage 1 (V_{DIOV1}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time 1 (t_{DIOV1}) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V. Discharge overcurrent release voltage (V_{RIOV}) is defined as the voltage V2 at which V_{DO} goes from "L" to "H" when setting V2 = 3.4 V, V5 = 0 V and when the voltage V2 is then gradually decreased.
When the voltage V2 falls below V_{RIOV}, V_{DO} will go to "H" after 1.0 ms typ. and maintain "H" during load short-circuiting detection delay time (t_{SHORT}).

4. Discharge overcurrent detection voltage 2 (Test circuit 2)

Discharge overcurrent detection voltage 2 (V_{DIOV2}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is discharge overcurrent detection delay time 2 (t_{DIOV2}) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V.

5. Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage (V_{SHORT}) is defined as the voltage V5 whose delay time for changing V_{DO} from "H" to "L" is t_{SHORT} when the voltage V5 is increased after setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V.

6. Load short-circuiting detection voltage 2 (Test circuit 2)

Load short-circuiting detection voltage 2 (V_{SHORT2}) is defined as the voltage V2 whose delay time for changing V_{DO} from "H" to "L" is t_{SHORT} when the voltage V2 is increased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.

7. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage (V_{CIOV}) is defined as the voltage V5 whose delay time for changing V_{CO} from "H" to "L" is charge overcurrent detection delay time (t_{CIOV}) when the voltage V5 is decreased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.

8. CTL pin voltage "H", CTL pin voltage "L" (Test circuit 2)

8. 1 CTL pin control logic active "H"

The CTL pin voltage "H" (V_{CTLH}) is defined as the voltage V6 at which V_{CO} and V_{DO} go from "H" to "L" when the voltage V6 is gradually increased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.
After that, the CTL pin voltage "L" (V_{CTLL}) is defined as the voltage V6 at which V_{CO} and V_{DO} go from "L" to "H" after V6 is gradually decreased.

8. 2 CTL pin control logic active "L"

V_{CTLL} is defined as the voltage difference between the voltage V6 and the voltage V1, V1 − V6, at which V_{CO} and V_{DO} go from "H" to "L" when the voltage V6 is gradually increased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V. After that, V_{CTLH} is defined as V1 − V6 at which V_{CO} and V_{DO} go from "L" to "H" after V6 is gradually decreased.

9. High-accuracy temperature protection circuit by an external NTC thermistor (Test circuit 6)

9. 1 High temperature charge-discharge inhibition temperature, high temperature charge-discharge inhibition release temperature

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, R5 = R_{NTC} [kΩ], and setting SW7 to off, R5 is gradually decreased. R5 is assigned to equation (1) when V_{CO} and V_{DO} go from "H" to "L". Temperature T [°C] obtained from the calculation result is defined as high temperature charge-discharge inhibition temperature (T_{HCD}). Subsequently, R5 is gradually increased. R5 is assigned to equation (1) when V_{CO} and V_{DO} go from "L" to "H". Temperature T [°C] obtained from the calculation result is defined as high temperature charge-discharge inhibition release temperature (T_{RHCD}). The difference between T_{HCD} and T_{RHCD} is defined as hysteresis temperature (T_{HYS}). When S-82D1A Series has the setting of high temperature charge inhibition temperature (T_{HC}) as well, only V_{DO} is switched as long as the detection temperature of an NTC thermistor is maintained at high temperature charge inhibition release temperature (T_{RHC}) or higher.

9. 2 High temperature charge inhibition temperature, high temperature charge inhibition release temperature

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, R5 = R_{NTC} [kΩ], and setting SW7 to off, R5 is gradually decreased. R5 is assigned to equation (1) when V_{CO} goes from "H" to "L". Temperature T [°C] obtained from the calculation result is defined as T_{HC}. Subsequently, R5 is gradually increased. R5 is assigned to equation (1) when V_{CO} goes from "L" to "H". Temperature T [°C] obtained from the calculation result is defined as T_{RHC}. The difference between T_{HC} and T_{RHC} is defined as T_{HYS}.

9. 3 Low temperature charge inhibition temperature, low temperature charge inhibition release temperature

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, R5 = R_{NTC} [kΩ], and setting SW7 to off, R5 is gradually increased. R5 is assigned to equation (1) when V_{CO} goes from "H" to "L". Temperature T [°C] obtained from the calculation result is defined as low temperature charge inhibition temperature (T_{LC}). Subsequently, R5 is gradually decreased. R5 is assigned to equation (1) when V_{CO} goes from "L" to "H". Temperature T [°C] obtained from the calculation result is defined as low temperature charge inhibition release temperature (T_{RLC}). The difference between T_{RLC} and T_{LC} is defined as T_{HYS}.

9. 4 Low temperature charge-discharge inhibition temperature, low temperature charge-discharge inhibition release temperature

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, R5 = R_{NTC} [kΩ], and setting SW7 to off, R5 is gradually increased. R5 is assigned to equation (1) when V_{CO} and V_{DO} go from "H" to "L". Temperature T [°C] obtained from the calculation result is defined as low temperature charge-discharge inhibition temperature (T_{LCD}). Subsequently, R5 is gradually decreased. R5 is assigned to equation (1) when V_{CO} and V_{DO} go from "L" to "H". Temperature T [°C] obtained from the calculation result is defined as low temperature charge-discharge inhibition release temperature (T_{RLCD}). The difference between T_{RLCD} and T_{LCD} is defined as T_{HYS}. When S-82D1A Series has the temperature setting of T_{LC} as well, only V_{DO} is switched as long as the detection temperature of an NTC thermistor is maintained at T_{RLC} or lower.

$$T\ [°C] = \frac{1}{\frac{1}{B\ [K]} \times \log_e \frac{R_5\ [k\Omega]}{R_{NTC}\ [k\Omega]} + \frac{1}{25\ [°C] + 273.15}} - 273.15 \cdots\cdots\cdots\cdots (1)$$

$$R_{TDET}\ [k\Omega] = R_{NTC}\ [k\Omega] \exp\left\{B\ [K]\left(\frac{1}{T_{DET}\ [°C] + 273.15} - \frac{1}{25\ [°C] + 273.15}\right)\right\} \cdots\cdots\cdots\cdots (2)$$

Remark Refer to **Table 6** for R_{NTC} [kΩ] and B [K].
Resistance R_{TDET} [kΩ] of an NTC thermistor at T_{DET} [°C] can be calculated by the equation (2).

10. Sampling wait time (Test circuit 6)

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V and setting SW7 to off, time interval when "L" is output between continuous voltage pulses output from the TH pin (V_{TH}) is defined as sampling wait time (t_{SLEEP}).

11. Continuous detection / release count (Test circuit 6)

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, SW7 is switched from off to on. The number of pulses from the SW7 switching until V_{CO} goes to "L" is continuous detection / release count (N).

12. Current consumption during operation (Test circuit 3)

The current consumption during operation (I_{OPE}) is the current that flows through the VDD pin (I_{DD}) under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V. However, the current flowing through the CTL pin internal resistance is excluded.

13. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

13. 1 With power-down function

The current consumption during power-down (I_{PDN}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = V6 = 0 V, V7 = 0.25 V.

13. 2 Without power-down function

The current consumption during overdischarge (I_{OPED}) is I_{DD} under the set conditions of V1 = V2 = 1.5 V, V5 = V6 = 0 V, V7 = 0.25 V.

14. Resistance between VDD pin and VM pin (Test circuit 3)

R_{VMD} is the resistance between VDD pin and VM pin under the set conditions of V1 = 1.8 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.

15. Resistance between VM pin and VSS pin (Test circuit 3)

R_{VMS} is the resistance between VM pin and VSS pin when the voltage V5 is decreased to 0 V after setting V1 = 3.4 V, V2 = V5 = 1.0 V, V6 = 0 V, V7 = 0.25 V.

16. CTL pin internal resistance (Test circuit 3)

16. 1 CTL pin control logic active "H", CTL pin internal resistance "pull-up"

The CTL pin internal resistance (R_{CTL}) is the resistance between CTL pin and VDD pin under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.

16. 2 CTL pin control logic active "H", CTL pin internal resistance "pull-down"

R_{CTL} is the resistance between CTL pin and VSS pin under the set conditions of V1 = V6 = 3.4 V, V2 = V5 = 0 V, V7 = 0.25 V.

16. 3 CTL pin control logic active "L", CTL pin internal resistance "pull-up"

R_{CTL} is the resistance between CTL pin and VDD pin under the set conditions of V1 = V6 = 3.4 V, V2 = V5 = 0 V, V7 = 0.25 V.

16. 4 CTL pin control logic active "L", CTL pin internal resistance "pull-down"

R_{CTL} is the resistance between CTL pin and VSS pin under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V.

17. CO pin resistance "H" (Test circuit 4)

The CO pin resistance "H" (R_{COH}) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V3 = 3.0 V, V7 = 0.25 V.

18. CO pin resistance "L" (Test circuit 4)

The CO pin resistance "L" (R_{COL}) is the resistance between VM pin and CO pin under the set conditions of V1 = 4.7 V, V2 = V5 = 0 V, V3 = 0.4 V, V7 = 0.25 V.

19. DO pin resistance "H" (Test circuit 4)

The DO pin resistance "H" (R_{DOH}) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V4 = 3.0 V, V7 = 0.25 V.

20. DO pin resistance "L" (Test circuit 4)

The DO pin resistance "L" (R_{DOL}) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V, V4 = 0.4 V, V7 = 0.25 V.

21. Overcharge detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V, the voltage V1 is increased. The time interval from when the voltage V1 exceeds V_{CU} until V_{CO} goes to "L" is the overcharge detection delay time (t_{CU}).

22. Overdischarge detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V, the voltage V1 is decreased. The time interval from when the voltage V1 falls below V_{DL} until V_{DO} goes to "L" is the overdischarge detection delay time (t_{DL}).

23. Discharge overcurrent detection delay time 1 (Test circuit 5)

After setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{DIOV1} until V_{DO} goes to "L" is the discharge overcurrent detection delay time 1 (t_{DIOV1}).

24. Discharge overcurrent detection delay time 2 (Test circuit 5)

After setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{DIOV2} until V_{DO} goes to "L" is the discharge overcurrent detection delay time 2 (t_{DIOV2}).

25. Load short-circuiting detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = 1.4 V, V5 = V6 = 0 V, V7 = 0.25 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{SHORT} until V_{DO} goes to "L" is the load short-circuiting detection delay time (t_{SHORT}).

26. Charge overcurrent detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V, the voltage V5 is decreased. The time interval from when the voltage V5 falls below V_{CIOV} until V_{CO} goes to "L" is the charge overcurrent detection delay time (t_{CIOV}).

27. Charge-discharge inhibition delay time (Test circuit 5)

27. 1 CTL pin control logic active "H"

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V, the voltage V6 is increased. The time interval from when the voltage V6 exceeds V_{CTLH} until V_{CO} and V_{DO} go to "L" is the charge-discharge inhibition delay time (t_{CTL}).

27. 2 CTL pin control logic active "L"

After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, V7 = 0.25 V, the voltage V6 is increased. The time interval from when the voltage V1 − V6 falls below V_{CTLL} until V_{CO} and V_{DO} go to "L" is t_{CTL}.

28. 0 V battery charge starting charger voltage (0 V battery charge enabled) (Test circuit 4)

The 0 V battery charge starting charger voltage (V_{0CHA}) is defined as the absolute value of voltage V2 at which the current flowing through the CO pin (I_{CO}) exceeds 1.0 μA when the voltage V2 is gradually decreased after setting V1 = V5 = 0 V, V2 = V3 = −0.5 V, V7 = 0.25 V.

29. 0 V battery charge inhibition battery voltage (0 V battery charge inhibited) (Test circuit 2)

The 0 V battery charge inhibition battery voltage (V_{0INH}) is defined as the voltage V1 at which V_{CO} goes to "L" (V_{CO} = V_{VM}) when the voltage V1 is gradually decreased after setting V1 = 1.8 V, V2 = −2.0 V, V5 = V6 = 0 V, V7 = 0.25 V.

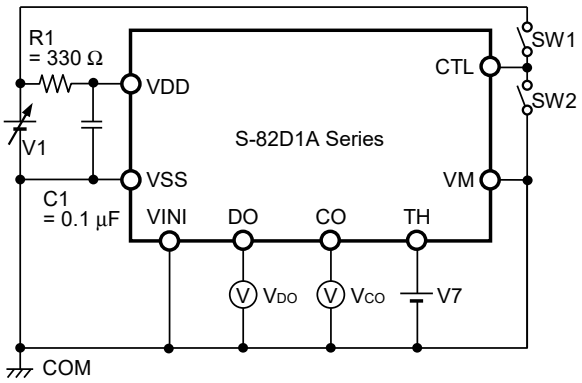


Figure 3 Test Circuit 1

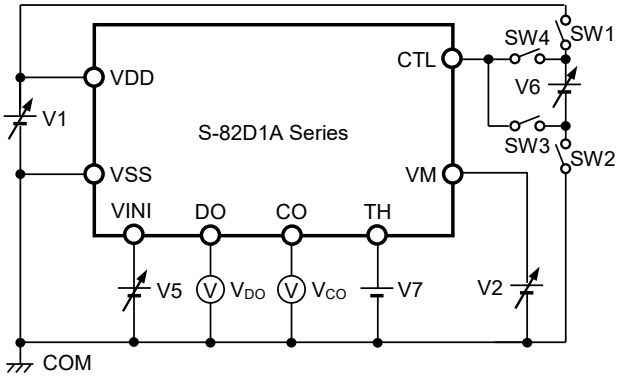


Figure 4 Test Circuit 2

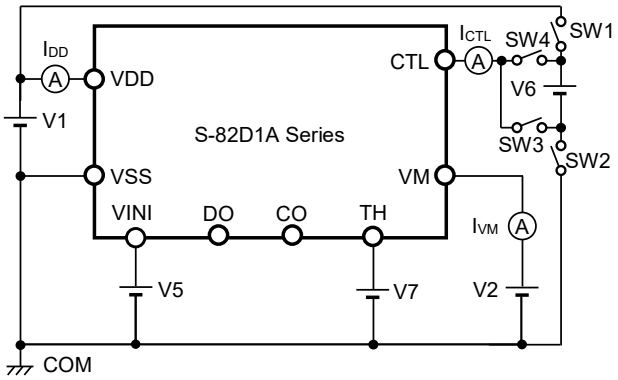


Figure 5 Test Circuit 3

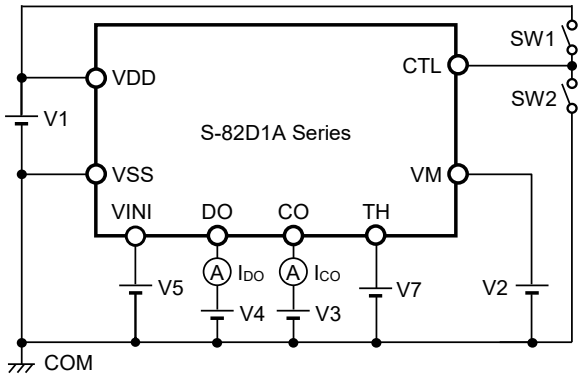


Figure 6 Test Circuit 4

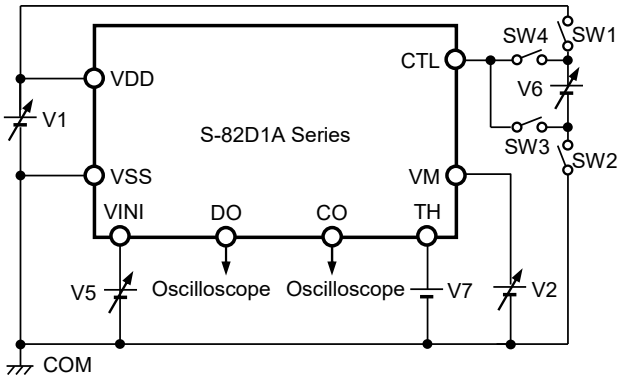


Figure 7 Test Circuit 5

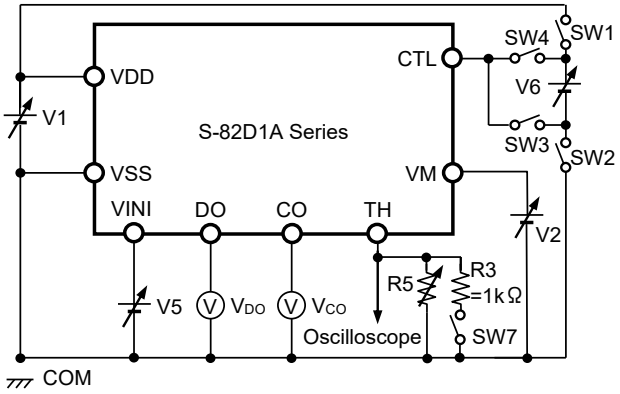


Figure 8 Test Circuit 6

■ Operation

Remark Refer to "■ **Battery Protection IC Connection Example**".

1. Normal status

The S-82D1A Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VINI pin and VSS pin, the voltage between CTL pin and VSS pin, and the resistance of an NTC thermistor to control charging and discharging.

1. 1 CTL pin control logic active "H"

The S-82D1A Series turns both the charge control FET and discharge control FET on when the battery voltage is in the range from overdischarge detection voltage (V_{DL}) to overcharge detection voltage (V_{CU}), the VINI pin voltage is in the range from charge overcurrent detection voltage (V_{CIOV}) to discharge overcurrent detection voltage 1 (V_{DIOV1}), the CTL pin voltage is equal to or lower than the CTL pin voltage "L" (V_{CTLL}), and the temperature of an NTC thermistor is in the range from low temperature charge inhibition temperature (T_{LC}) to high temperature charge inhibition temperature (T_{HC}). This status is called the normal status, and in this condition charging and discharging can be carried out freely.
The resistance between VDD pin and VM pin (R_{VMD}), and the resistance between VM pin and VSS pin (R_{VMS}) are not connected in the normal status.

1. 2 CTL pin control logic active "L"

The S-82D1A Series turns both the charge control FET and discharge control FET on when the battery voltage is in the range from V_{DL} to V_{CU}, the VINI pin voltage is in the range from V_{CIOV} to V_{DIOV1}, the CTL pin voltage is equal to or higher than the CTL pin voltage "H" (V_{CTLH}), and the temperature of an NTC thermistor is in the range from T_{LC} to T_{HC}. This status is called the normal status, and in this condition charging and discharging can be carried out freely.
R_{VMD} and R_{VMS} are not connected in the normal status.

Caution After the battery is connected, discharging may not be carried out. In this case, the S-82D1A Series returns to the normal status by connecting a charger.

2. Overcharge status

2. 1 $V_{CL} \neq V_{CU}$ (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for the overcharge detection delay time (t_{CU}) or longer, the S-82D1A Series turns the charge control FET off to stop charging. This status is called the overcharge status.
The overcharge status is released in the following two cases.

(1) In the case that the VM pin voltage is lower than 0.35 V typ., the S-82D1A Series releases the overcharge status when the battery voltage falls below overcharge release voltage (V_{CL}).
(2) In the case that the VM pin voltage is equal to or higher than 0.35 V typ., the S-82D1A Series releases the overcharge status when the battery voltage falls below V_{CU}.

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the internal parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82D1A Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU}.

Caution If the battery is charged to a voltage higher than V_{CU} and the battery voltage does not fall below V_{CU} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{CU}. Since an actual battery has an internal impedance of tens of mΩ, the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

2. 2 V_{CL} = V_{CU} (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than V_{CU} during charging in the normal status and the condition continues for t_{CU} or longer, the S-82D1A Series turns the charge control FET off to stop charging. This status is called the overcharge status.
In the case that the VM pin voltage is equal to or higher than 0.35 V typ. and the battery voltage falls below V_{CU}, the S-82D1A Series releases the overcharge status.

When the discharge is started by connecting a load after the overcharge detection, the VM pin voltage rises by the V_f voltage of the internal parasitic diode than the VSS pin voltage, because the discharge current flows through the parasitic diode in the charge control FET. If this VM pin voltage is equal to or higher than 0.35 V typ., the S-82D1A Series releases the overcharge status when the battery voltage is equal to or lower than V_{CU}.

Caution 1. If the battery is charged to a voltage higher than V_{CU} and the battery voltage does not fall below V_{CU} even when a heavy load is connected, discharge overcurrent detection and load short-circuiting detection do not function until the battery voltage falls below V_{CU}. Since an actual battery has an internal impedance of tens of mΩ, the battery voltage drops immediately after a heavy load that causes overcurrent is connected, and discharge overcurrent detection and load short-circuiting detection function.

2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below V_{CL}. The overcharge status is released when the discharge current flows and the VM pin voltage goes over 0.35 V typ. by removing the charger.

3. Overdischarge status

When the battery voltage falls below V_{DL} during discharging in the normal status and the condition continues for the overdischarge detection delay time (t_{DL}) or longer, the S-82D1A Series turns the discharge control FET off to stop discharging. This status is called the overdischarge status.
Under the overdischarge status, VDD pin and VM pin are shorted by R_{VMD} in the S-82D1A Series. The VM pin voltage is pulled up by R_{VMD}.
When connecting a charger in the overdischarge status, the battery voltage reaches V_{DL} or higher and the S-82D1A Series releases the overdischarge status if the VM pin voltage is below 0 V typ.
The battery voltage reaches the overdischarge release voltage (V_{DU}) or higher and the S-82D1A Series releases the overdischarge status if the VM pin voltage is not below 0 V typ.
R_{VMS} is not connected in the overdischarge status.

3. 1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down (I_{PDN}). By connecting a battery charger, the power-down function is released when the VM pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the S-82D1A Seies maintains the overdischarge status even when the battery voltage reaches V_{DU} or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82D1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82D1A Series releases the overdischarge status.

3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VM pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VM pin voltage ≥ 0.7 V typ., the battery voltage reaches V_{DU} or higher and the S-82D1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VM pin voltage > 0 V typ., the battery voltage reaches V_{DU} or higher and the S-82D1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VM pin voltage, the battery voltage reaches V_{DL} or higher and the S-82D1A Series releases the overdischarge status.

4. Discharge overcurrent status (discharge overcurrent 1, discharge overcurrent 2, load short-circuiting, load short-circuiting 2)

4. 1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting

When a battery in the normal status is in the status where the VINI pin voltage is equal to or higher than V_{DIOV1} because the discharge current is equal to or higher than the specified value and the status continues for the discharge overcurrent detection delay time 1 (t_{DIOV1}) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

Under the discharge overcurrent status, VM pin and VSS pin are shorted by R_{VMS} in the S-82D1A Series. However, the VM pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, VM pin returns to the VSS pin voltage.
When the VM pin voltage returns to V_{RIOV} or lower, the S-82D1A Series releases the discharge overcurrent status.
R_{VMD} is not connected in the discharge overcurrent status.

4. 2 Load short-circuiting 2

When a battery in the normal status is in the status where a load causing discharge overcurrent is connected, and the VM pin voltage is equal to or higher than V_{SHORT2} and the status continues for the load short-circuiting detection delay time (t_{SHORT}) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.
The S-82D1A Series releases the discharge overcurrent status in the same way as in "**4. 1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting**".

4. 3 Discharge overcurrent status reset function by CTL pin

4. 3. 1 With discharge overcurrent status reset function by CTL pin

Under the discharge overcurrent status, when the CTL pin is active and the condition continues for the charge-discharge inhibition delay time (t_{CTL}) or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. The S-82D1A Series then becomes the charge-discharge inhibition status.
The S-82D1A Series returns to the normal status if the CTL pin is made inactive and the charge-discharge inhibition status is released.

4. 3. 2 Without discharge overcurrent status reset function by CTL pin

Under the discharge overcurrent status, even when the CTL pin is active and the condition continues for t_{CTL} or longer, the S-82D1A Series does not become the charge-discharge inhibition status and maintains the discharge overcurrent status.
The S-82D1A Series does not return to the normal status and maintains the discharge overcurrent status even if the CTL pin is made inactive.

5. Charge overcurrent status

When a battery in the normal status is in the status where the VINI pin voltage is equal to or lower than V_{CIOV} because the charge current is equal to or higher than the specified value and the status continues for the charge overcurrent detection delay time (t_{CIOV}) or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.
The S-82D1A Series releases the charge overcurrent status when the discharge current flows and the VM pin voltage is 0.35 V typ. or higher by removing the charger.
The charge overcurrent detection does not function in the overdischarge status.

6. Charge-discharge inhibition status

6. 1 CTL pin control logic active "H"

When the CTL pin voltage is equal to or higher than CTL pin voltage "H" (V_{CTLH}) and the status continues for the charge-discharge inhibition delay time (t_{CTL}) or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status.
The S-82D1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or lower than CTL pin voltage "L" (V_{CTLL}).

6. 2 CTL pin control logic active "L"

When the CTL pin voltage is equal to or lower than V_{CTLL} and the status continues for t_{CTL} or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status.
The S-82D1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or higher than V_{CTLH}.

6. 3 CTL pin internal resistance connection

6. 3. 1 CTL pin internal resistance "pull-up"

The CTL pin is shorted to the VDD pin by the CTL pin internal resistance (R_{CTL}).

6. 3. 2 CTL pin internal resistance "pull-down"

The CTL pin is shorted to the VSS pin by R_{CTL}.
When the S-82D1A Series becomes overdischarge status, R_{CTL} is disconnected, and the input current and the output current to the CTL pin are cut off.
The charge-discharge control by the CTL pin does not function in the overdischarge status.

7. Temperature protection status (high temperature charge-discharge inhibition status, high temperature charge inhibition status, low temperature charge inhibition status, low temperature charge-discharge inhibition status)

The S-82D1A Series carries out intermittent operation in the normal status.
The S-82D1A Series monitors the temperature of an NTC thermistor for the sampling time (t_{AWAKE}) of 4 ms typ. after sampling wait time (t_{SLEEP}).

7. 1 High temperature charge-discharge inhibition status

When the temperature of an NTC thermistor is equal to or higher than high temperature charge-discharge inhibition temperature (T_{HCD}) and the condition continues until the number of the temperature sampling reaches continuous detection / release count (N), the S-82D1A Series becomes the high temperature charge-discharge inhibition status.
Under the high temperature charge-discharge inhibition status, both the charge control FET and discharge control FET are turned off, and charging and discharging are stopped.
The S-82D1A Series releases the high temperature charge-discharge inhibition status when the temperature of the NTC thermistor falls below T_{HCD} by hysteresis temperature (T_{HYS}) and the condition continues until the number of the temperature sampling reaches N.

7. 2 High temperature charge inhibition status

When the temperature of an NTC thermistor is equal to or higher than high temperature charge inhibition temperature (T_{HC}) and the condition continues until the number of the temperature sampling reaches N, the S-82D1A Series becomes the high temperature charge inhibition status.

- When a battery is not connected to a charger and the VM pin voltage > 3 mV typ., the charge control FET is not turned off.
- When a battery is connected to a charger and 3 mV typ. ≥ the VM pin voltage, the charge control FET is turned off and charging is stopped.

The S-82D1A Series releases the high temperature charge inhibition status when the temperature of the NTC thermistor falls below T_{HC} by T_{HYS} and the condition continues until the number of the temperature sampling reaches N.

7. 3 Low temperature charge inhibition status

When the temperature of an NTC thermistor is equal to or lower than low temperature charge inhibition temperature (T_{LC}) and the condition continues until the number of the temperature sampling reaches N, the S-82D1A Series becomes the low temperature charge inhibition status.

- When a battery is not connected to a charger and the VM pin voltage > 3 mV typ., the charge control FET is not turned off.
- When a battery is connected to a charger and 3 mV typ. ≥ the VM pin voltage, the charge control FET is turned off and charging is stopped.

The S-82D1A Series releases the low temperature charge inhibition status when the temperature of the NTC thermistor exceeds T_{LC} by T_{HYS} and the condition continues until the number of the temperature sampling reaches N.

7. 4 Low temperature charge-discharge inhibition status

When the temperature of an NTC thermistor is equal to or lower than low temperature charge-discharge inhibition temperature (T_{LCD}) and the condition continues until the number of the temperature sampling reaches N, the S-82D1A Series becomes the low temperature charge-discharge inhibition status.
Under the low temperature charge-discharge inhibition status, both the charge control FET and discharge control FET are turned off, and charging and discharging are stopped.
The S-82D1A Series releases the low temperature charge-discharge inhibition status when the temperature of the NTC thermistor exceeds T_{LCD} by T_{HYS} and the condition continues until the number of the temperature sampling reaches N.

8. 0 V battery charge enabled

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage (V_{0CHA}) or a higher voltage is applied between the EB+ and EB− pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage.
When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than V_{DL}, the S-82D1A Series returns to the normal status.

Caution 1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. It depends on the characteristics of the lithium-ion rechargeable battery to be used; therefore, please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.
2. The 0 V battery charge has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than V_{DL}.

9. 0 V battery charge inhibited

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage (V_{0INH}) or lower, the charge control FET gate is fixed to the EB− pin voltage to inhibit charging. When the battery voltage is V_{0INH} or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. It depends on the characteristics of the lithium-ion rechargeable battery to be used; therefore, please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge.

10. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

Remark t_{DIOV1}, t_{DIOV2} and t_{SHORT} start when V_{DIOV1} is detected. When V_{DIOV2} or V_{SHORT} is detected over t_{DIOV2} or t_{SHORT} after the detection of V_{DIOV1}, the S-82D1A Series turns the discharge control FET off within t_{DIOV2} or t_{SHORT} of each detection.

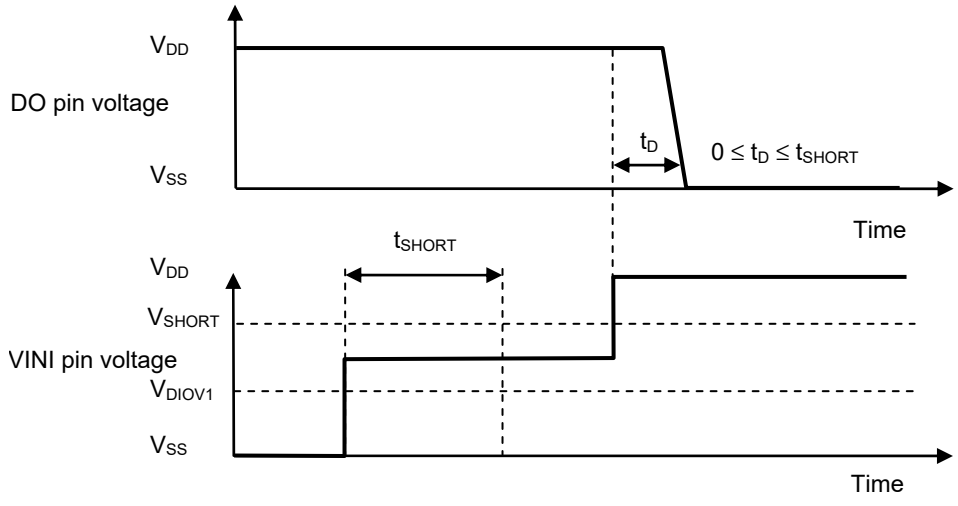


Figure 9

■ Timing Charts

1. Overcharge detection, overdischarge detection

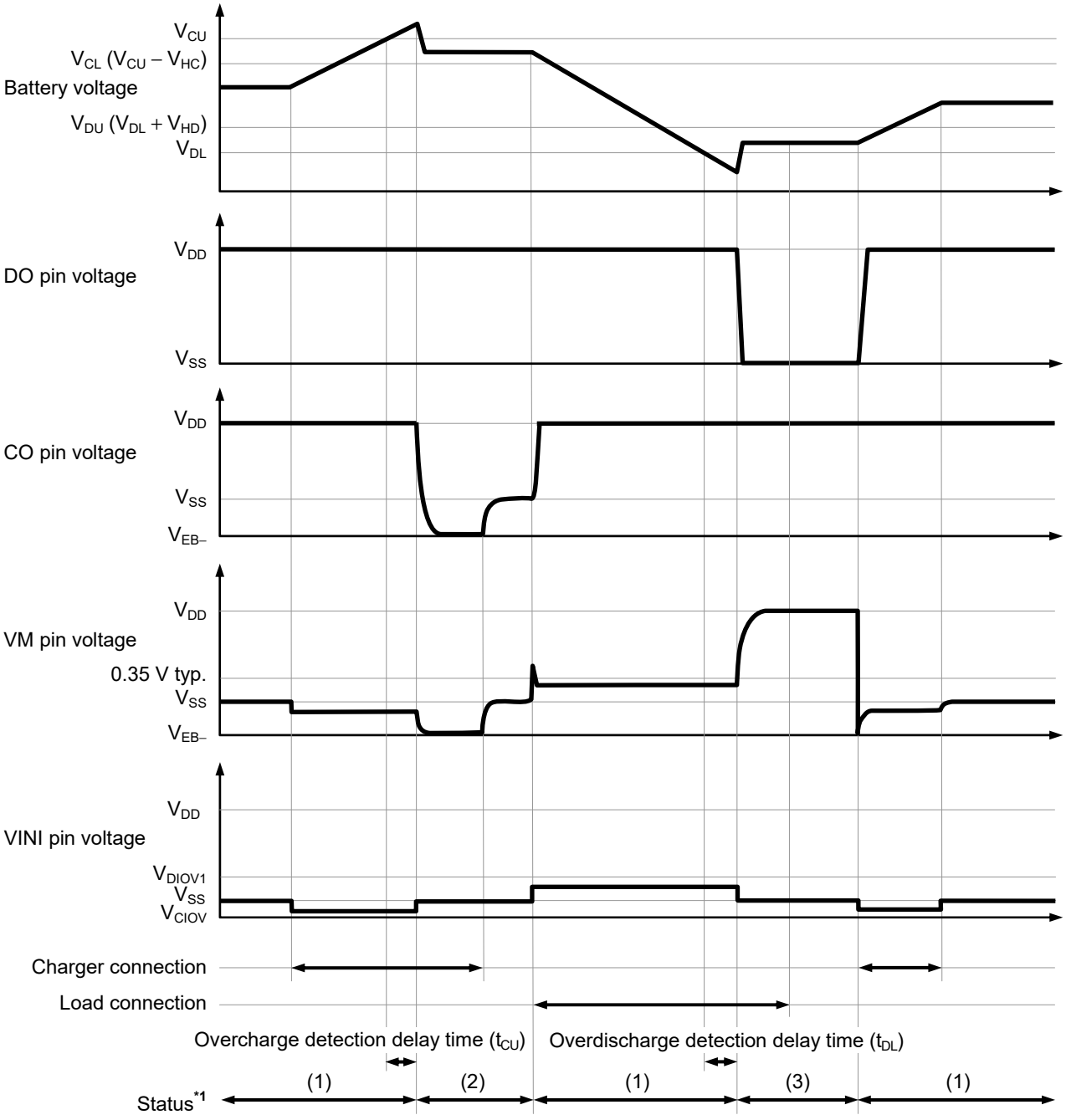


Figure 10

***1.** (1): Normal status
(2): Overcharge status
(3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

2. Discharge overcurrent detection

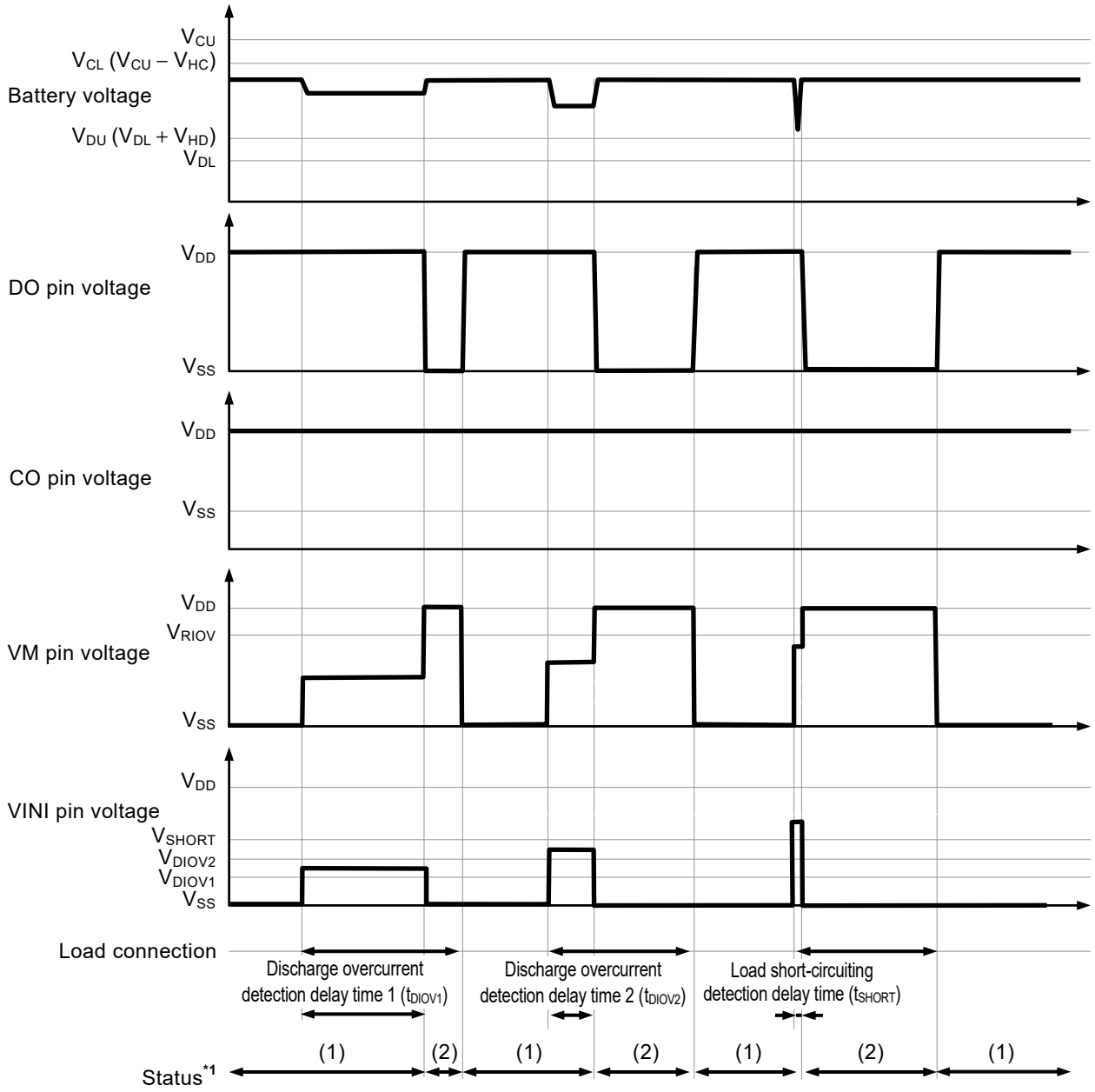


Figure 11

***1.** (1): Normal status
(2): Discharge overcurrent status

3. Charge overcurrent detection

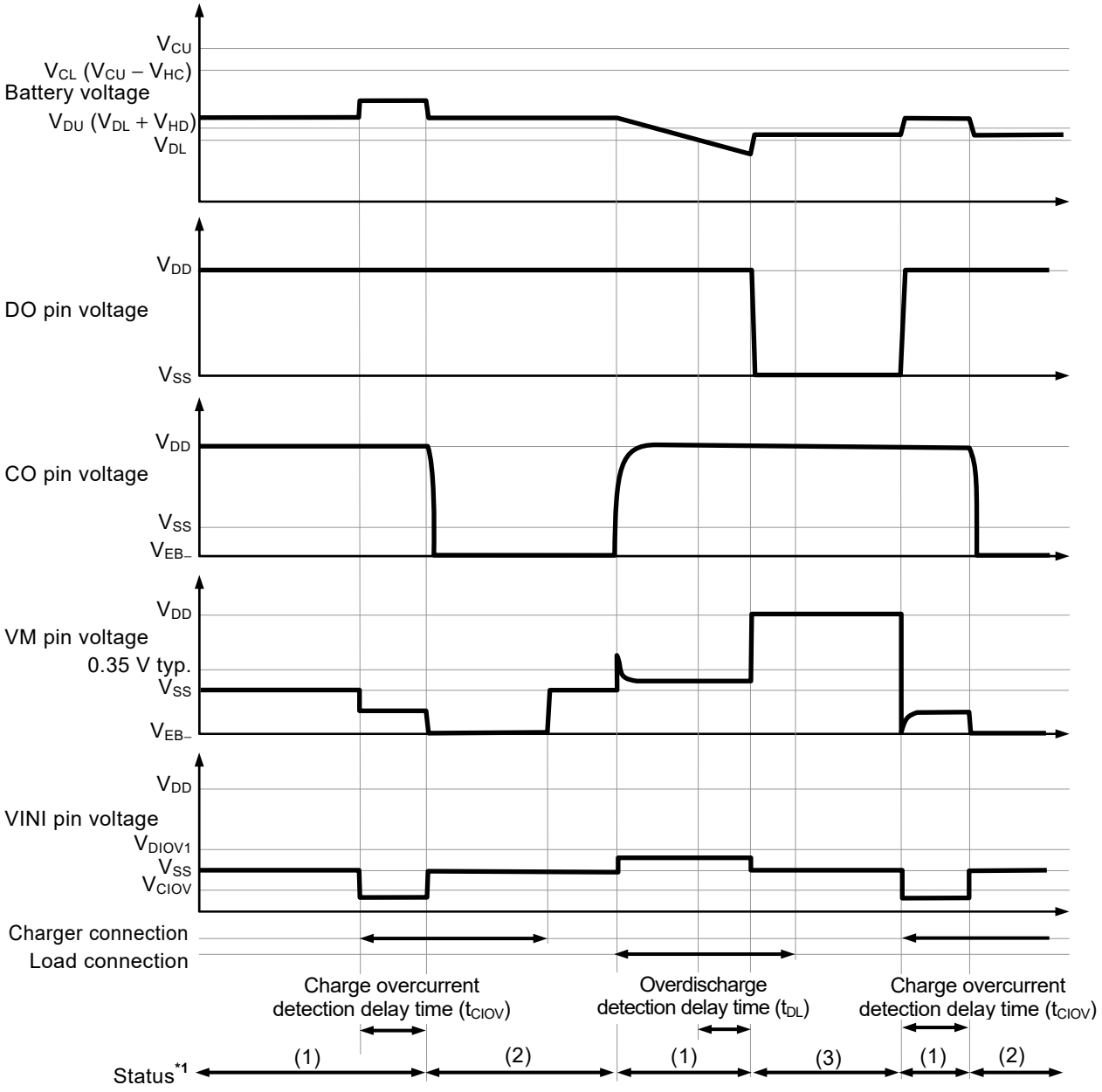


Figure 12

***1.** (1): Normal status
(2): Charge overcurrent status
(3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

4. Charge-discharge inhibition operation

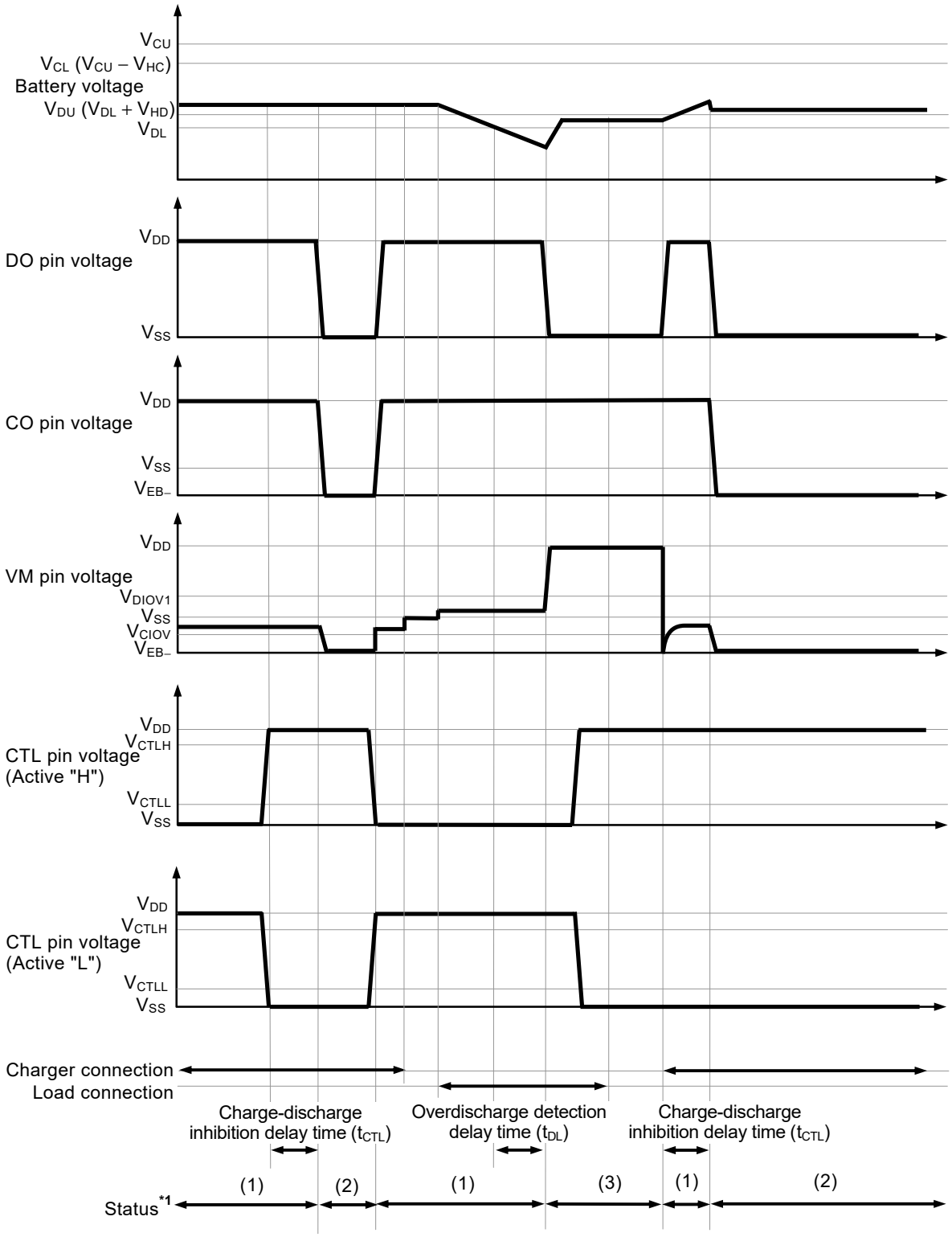


Figure 13

***1.** (1): Normal status
(2): Charge-discharge inhibition status
(3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

5. Temperature protection operation

5. 1 High temperature charge inhibition temperature detection

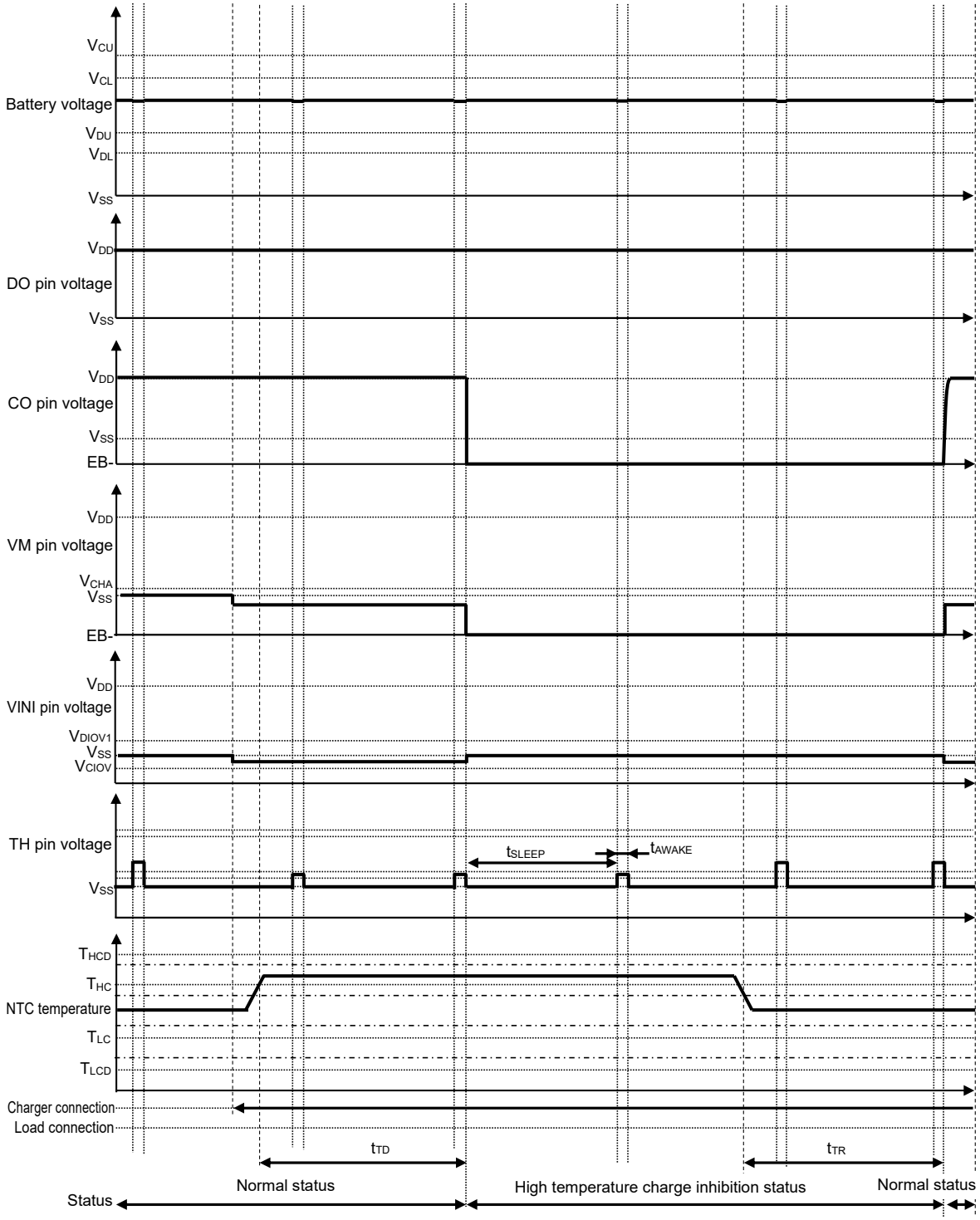


Figure 14

Remark 1. **Figure 14** shows an example when N = 2. t_{TD} and t_{TR} have the following ranges.
$(t_{SLEEP} + t_{AWAKE}) \times N - t_{SLEEP} \leq t_{TD} \leq (t_{SLEEP} + t_{AWAKE}) \times N$
$(t_{SLEEP} + t_{AWAKE}) \times N - t_{SLEEP} \leq t_{TR} \leq (t_{SLEEP} + t_{AWAKE}) \times N$

2. t_{TD}: Delay time to detect high temperature charge inhibition temperature
t_{TR}: Delay time to detect high temperature charge inhibition release temperature

5. 2 High temperature charge-discharge inhibition temperature detection

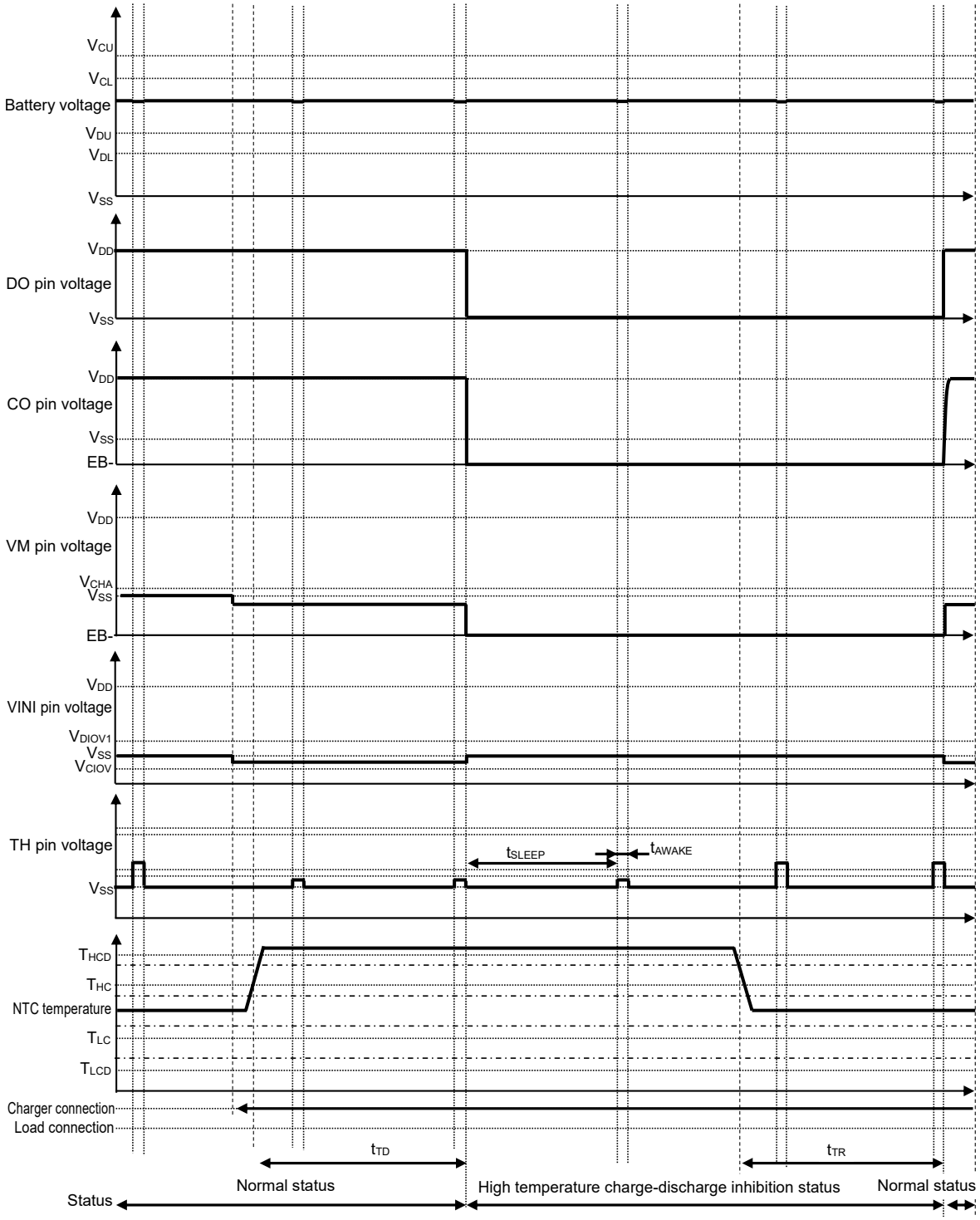


Figure 15

Remark 1. **Figure 15** shows a time chart when N = 2 and the temperature of an NTC thermistor changes from below T_{HC} to above T_{HCD}.
Since the temperature of the NTC thermistor is above T_{HCD} twice in a row at sampling, S-82D1A Series switches from the normal status to the high temperature charge-discharge inhibition status.

2. t_{TD}: Delay time to detect high temperature charge-discharge inhibition temperature

t_{TR}: Delay time to detect high temperature charge-discharge inhibition release temperature

■ Battery Protection IC Connection Example

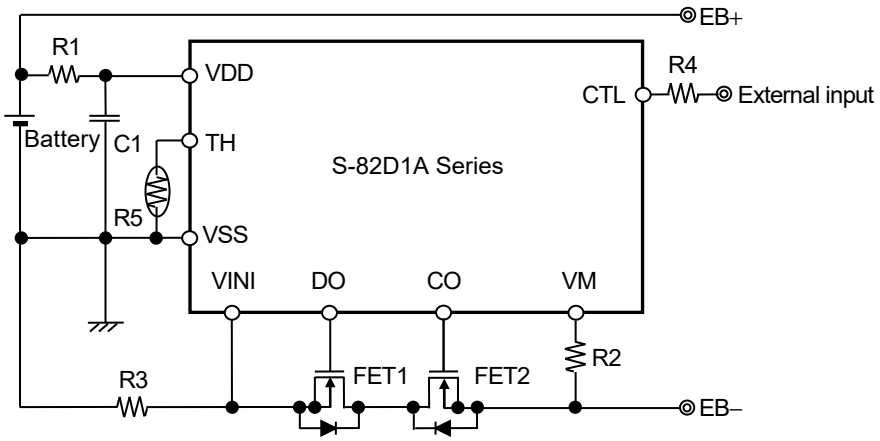


Figure 16

Table 14 Constants for External Components

Symbol	Part	Purpose	Min.	Typ.	Max.	Remark
FET1	N-channel MOS FET	Discharge control	–	–	–	Threshold voltage ≤ Overdischarge detection voltage*1
FET2	N-channel MOS FET	Charge control	–	–	–	Threshold voltage ≤ Overdischarge detection voltage*1
R1	Resistor	ESD protection, For power fluctuation	270 Ω	330 Ω	1.2 kΩ*2	–
C1	Capacitor	For power fluctuation	0.068 μF	0.1 μF	2.2 μF	–
R2	Resistor	ESD protection, Protection for reverse connection of a charger	300 Ω	470 Ω	1.5 kΩ	–
R3	Resistor	Overcurrent detection	–	1.5 mΩ	–	–
R4	Resistor	CTL pin input protection	–	1 kΩ	–	–
R5	NTC Thermistor	Temperature sensing	10 kΩ*3	100 kΩ*3	100 kΩ*3	–

***1.** If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

***2.** Accuracy of overcharge detection voltage is guaranteed by R1 = 330 Ω. Connecting resistors with other values will worsen the accuracy.

***3.** Temperature detection accuracy varies with NTC thermistor specifications.
When an NTC thermistor listed in **Table 6** is connected, the detection temperature and accuracy can be achieved.

Caution 1. The constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the connection example. In addition, the connection example and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

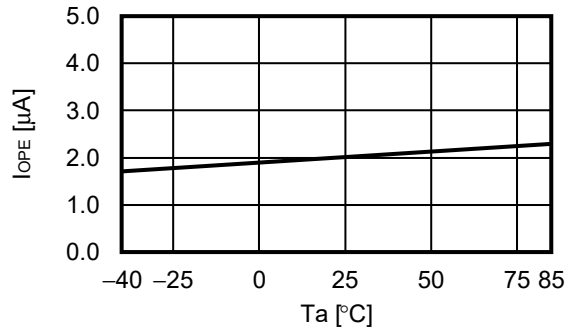
■ Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc. claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

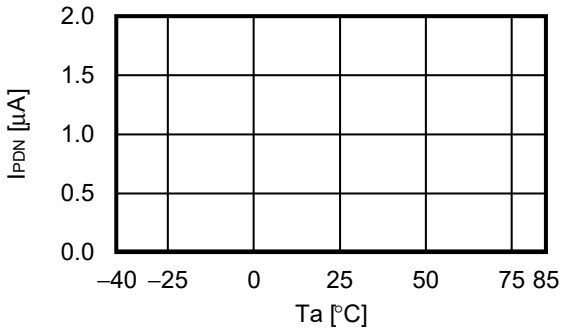
■ Characteristics (Typical Data)

1. Current consumption

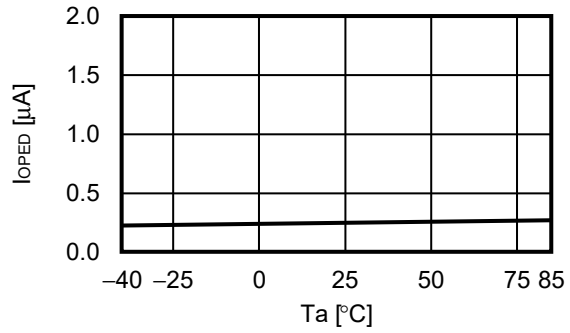
1. 1 I_{OPE} vs. Ta



1. 2 I_{PDN} vs. Ta

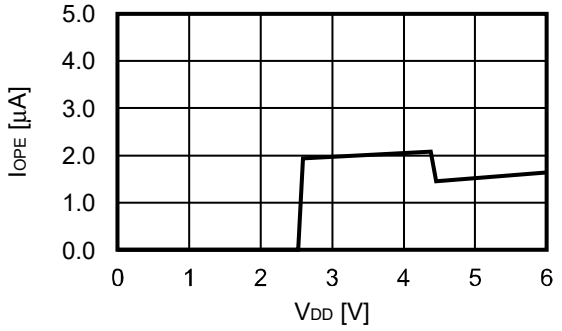


1. 3 I_{OPED} vs. Ta

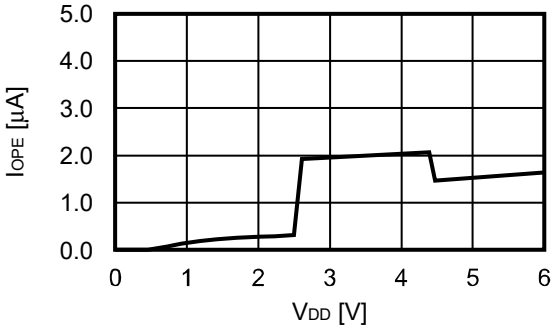


1. 4 I_{OPE} vs. V_{DD}

1. 4. 1 With power-down function

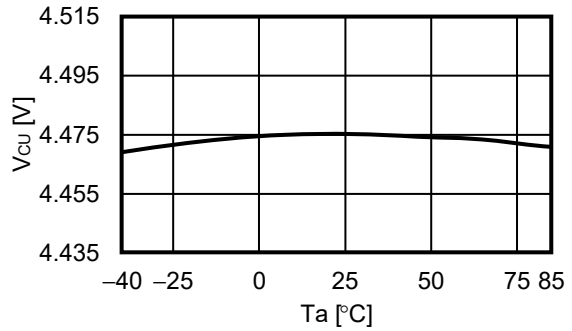


1. 4. 2 Without power-down function

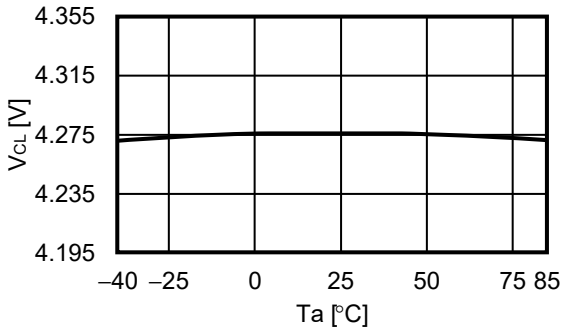


2. Detection voltage, release voltage

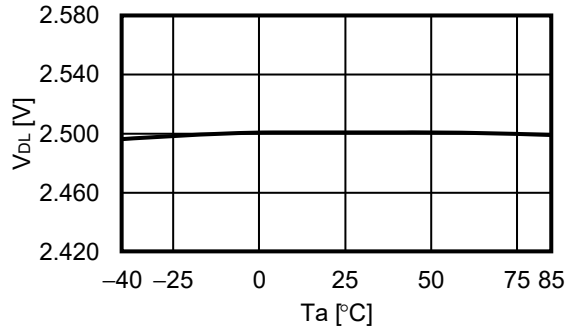
2. 1 V_{CU} vs. Ta



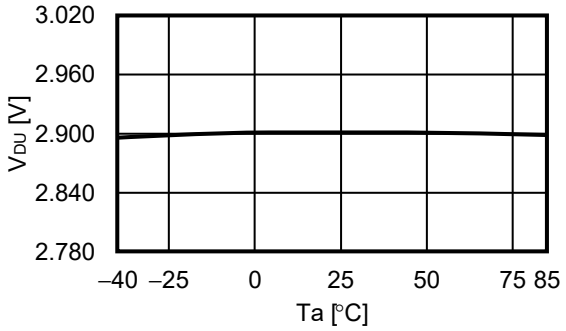
2. 2 V_{CL} vs. Ta



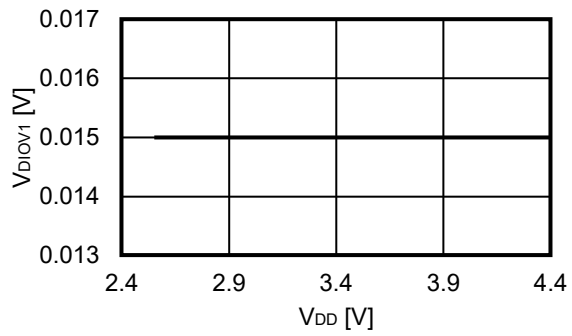
2. 3 V_{DL} vs. Ta



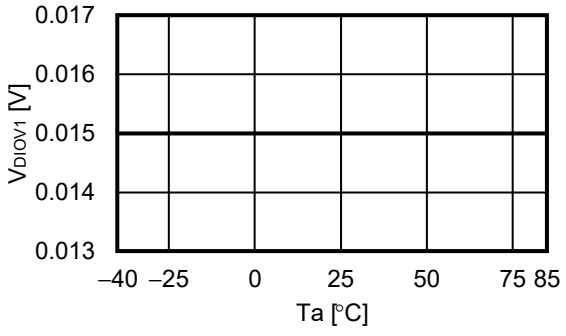
2. 4 V_{DU} vs. Ta



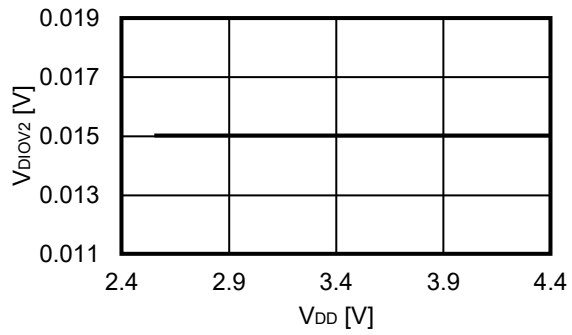
2. 5 V_{DIOV1} vs. V_{DD}



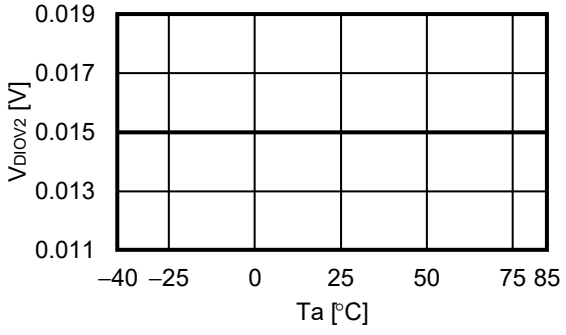
2. 6 V_{DIOV1} vs. Ta



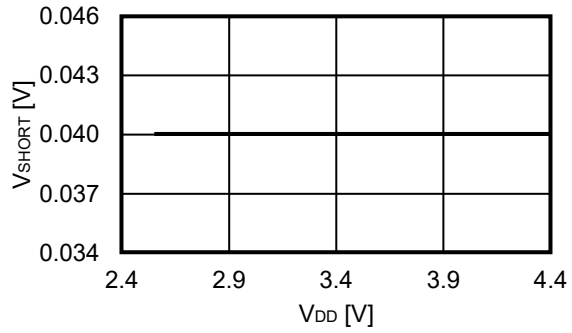
2. 7 V_{DIOV2} vs. V_{DD}



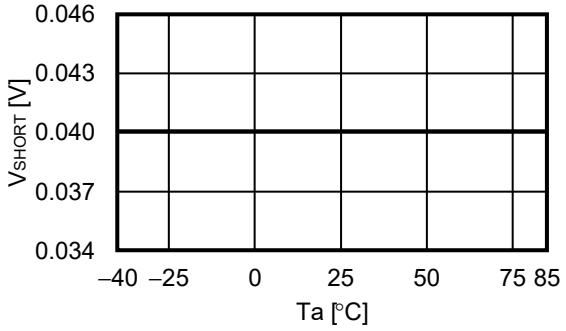
2. 8 V_{DIOV2} vs. Ta



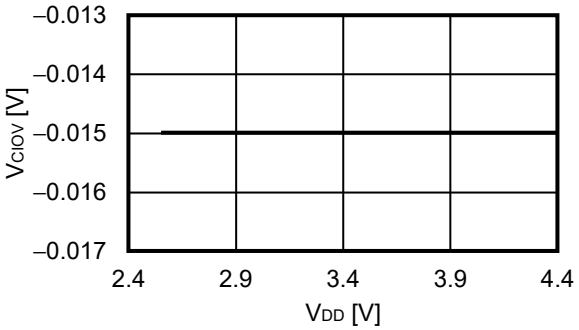
2. 9 V_{SHORT} vs. V_{DD}



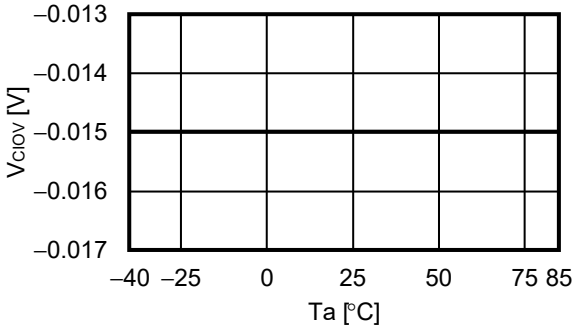
2. 10 V_{SHORT} vs. Ta



2. 11 V_{CIOV} vs. V_{DD}

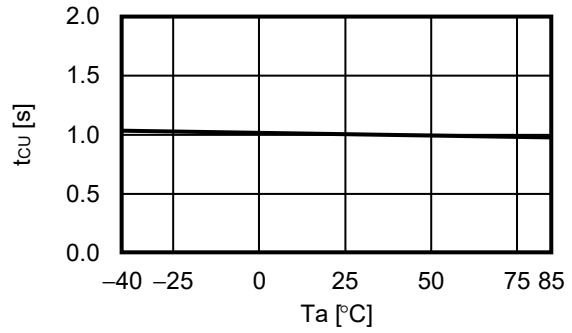


2. 12 V_{CIOV} vs. Ta

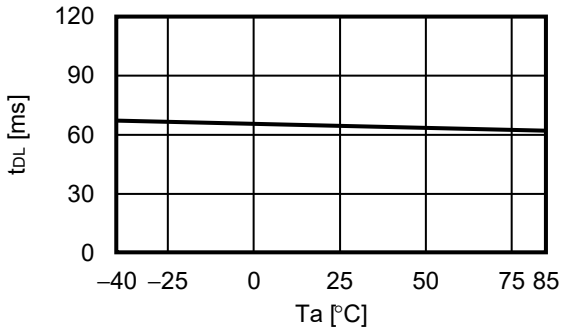


3. Delay time

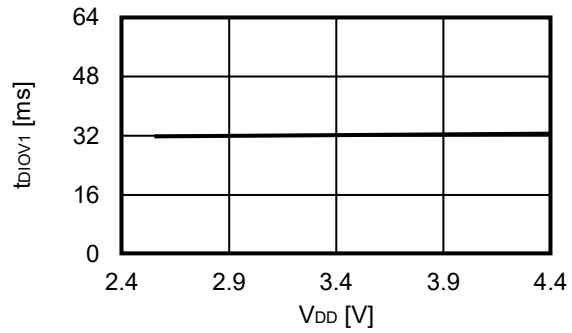
3. 1 t_{CU} vs. Ta



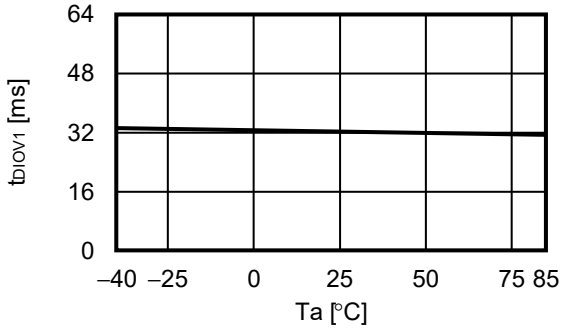
3. 2 t_{DL} vs. Ta



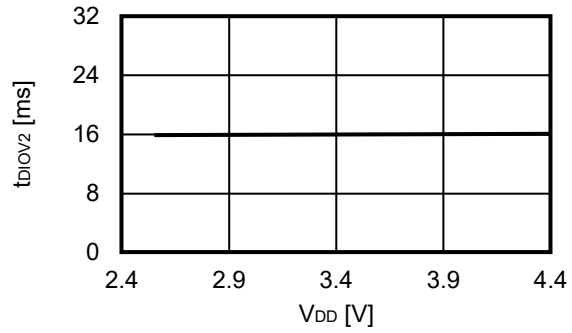
3. 3 t_{DIOV1} vs. V_{DD}



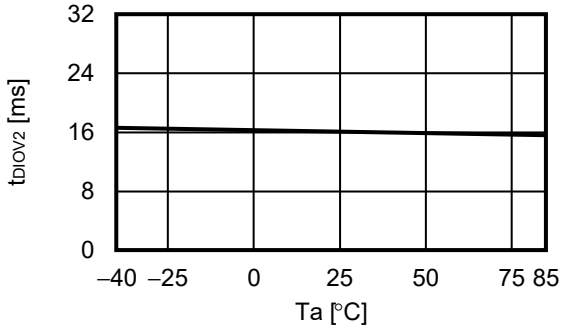
3. 4 t_{DIOV1} vs. Ta



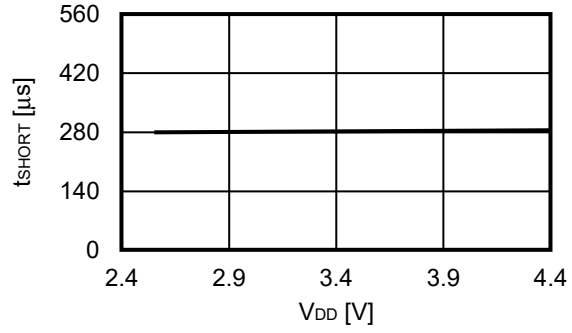
3. 5 t_{DIOV2} vs. V_{DD}



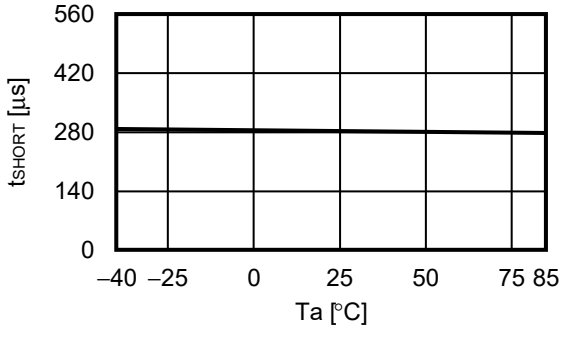
3. 6 t_{DIOV2} vs. Ta



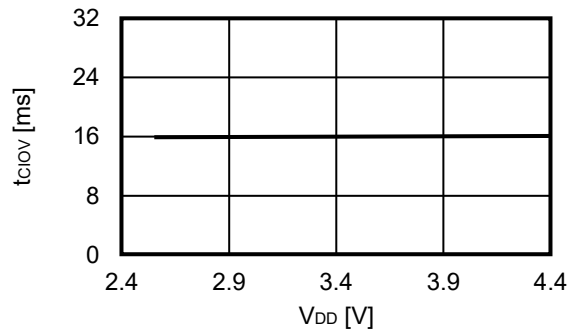
3. 7 t_{SHORT} vs. V_{DD}



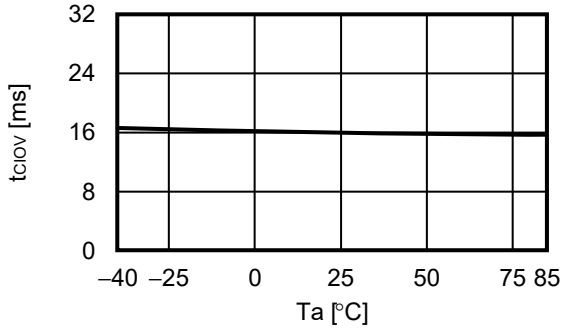
3. 8 t_{SHORT} vs. Ta



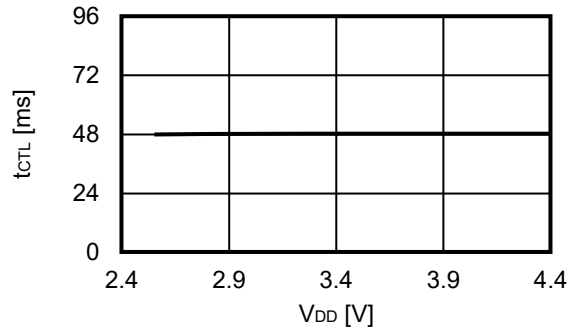
3. 9 t_{CIOV} vs. V_{DD}



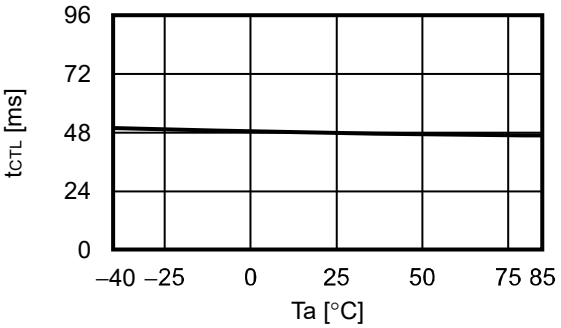
3. 10 t_{CIOV} vs. Ta



3. 11 t_{CTL} vs. V_{DD}

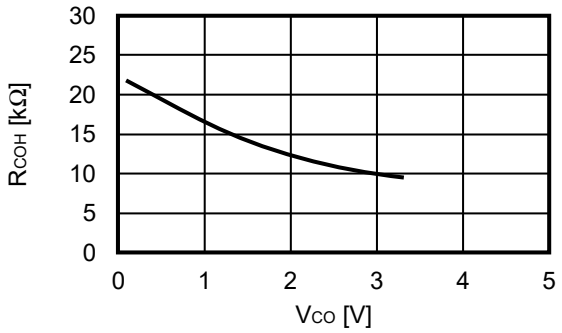


3. 12 t_{CTL} vs. Ta

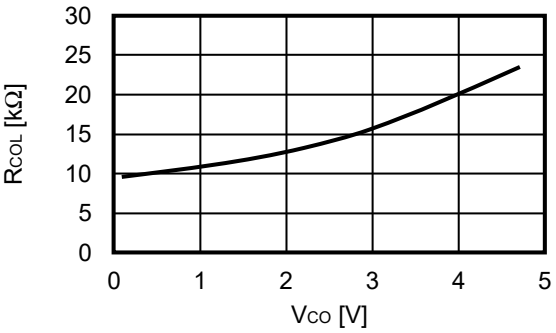


4. Output resistance

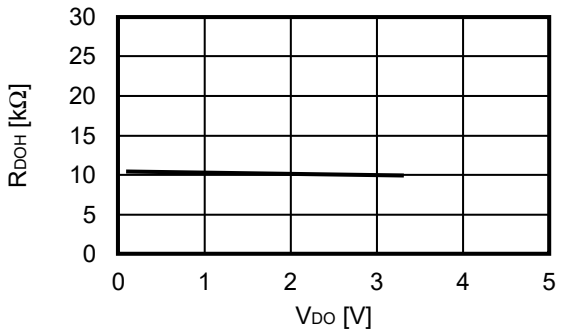
4. 1 R_{COH} vs. V_{CO}



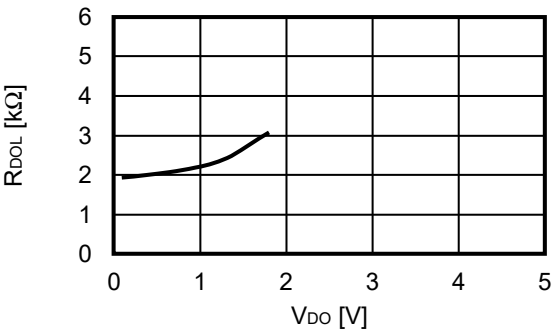
4. 2 R_{COL} vs. V_{CO}



4. 3 R_{DOH} vs. V_{DO}

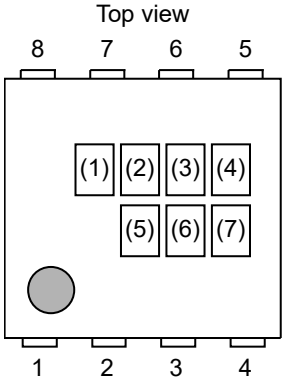


4. 4 R_{DOL} vs. V_{DO}



■ Marking Specifications

1. HSNT-8(1616)



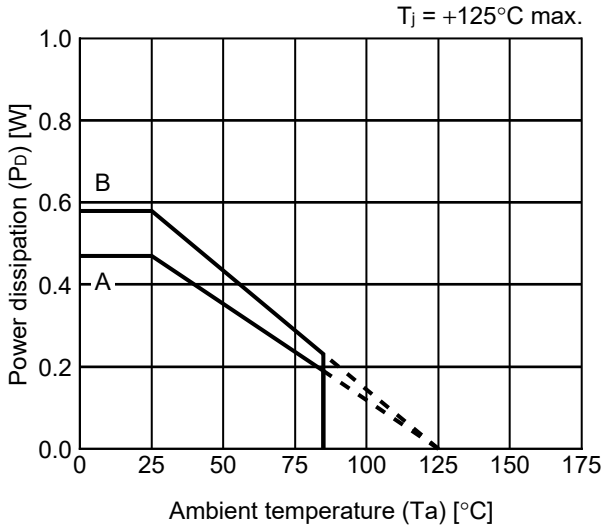
(1): Product code (Blank)
(2) to (4): Product code (refer to **Product name vs. Product code**)
(5) to (7): Lot number

Product name vs. Product code

Product Name	Product Code		
	(2)	(3)	(4)
S-82D1AAA-A8T2U7	7	4	A
S-82D1AAB-A8T2U7	7	4	B
S-82D1AAD-A8T2U7	7	4	E
S-82D1AAE-A8T2U7	7	4	F
S-82D1AAI-A8T2U7	7	4	K
S-82D1AAJ-A8T2U7	7	4	L
S-82D1AAK-A8T2U7	7	4	M
S-82D1AAL-A8T2U7	7	4	N
S-82D1AAM-A8T2U7	7	4	O
S-82D1AAN-A8T2U7	7	4	P
S-82D1AAO-A8T2U7	7	4	Q
S-82D1AAP-A8T2U7	7	4	R
S-82D1AAQ-A8T2U7	7	4	S

■ Power Dissipation

HSNT-8(1616)

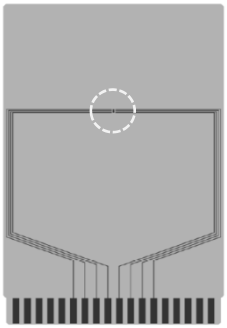


Board	Power Dissipation (P_D)
A	0.47 W
B	0.58 W
C	–
D	–
E	–

HSNT-8(1616) Test Board

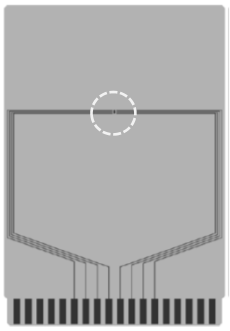
IC Mount Area

(1) Board A



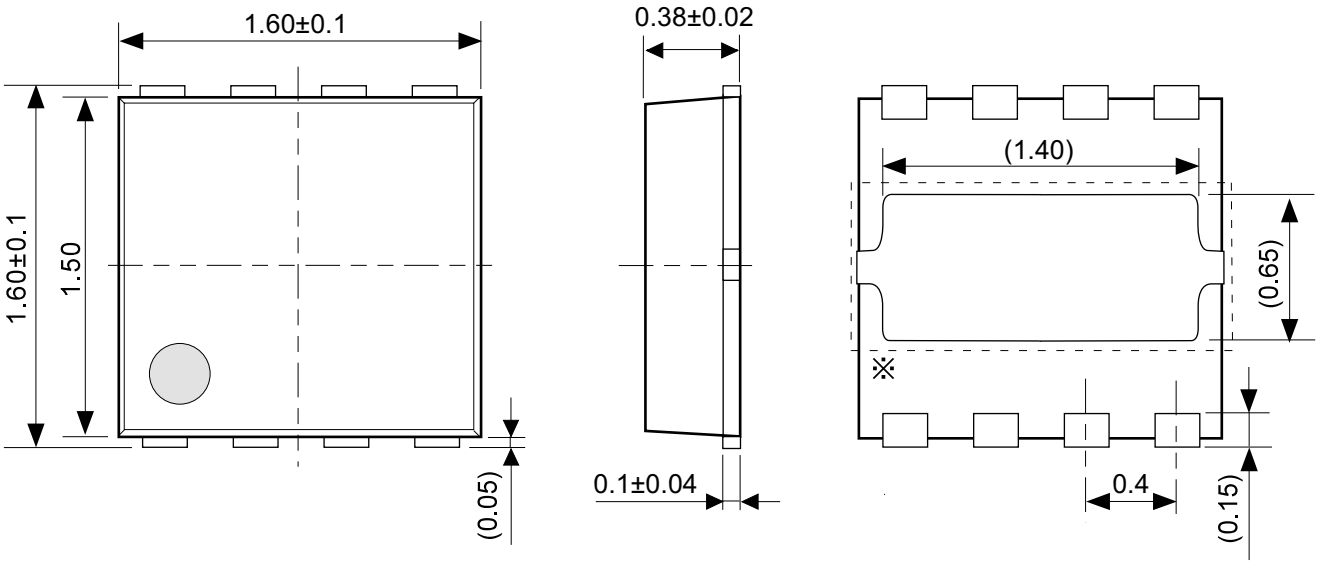
Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

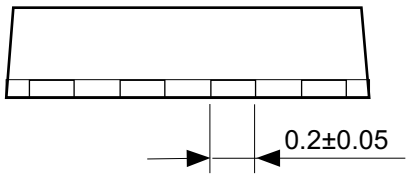
(2) Board B



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

No. HSNT8-B-Board-SD-1.0

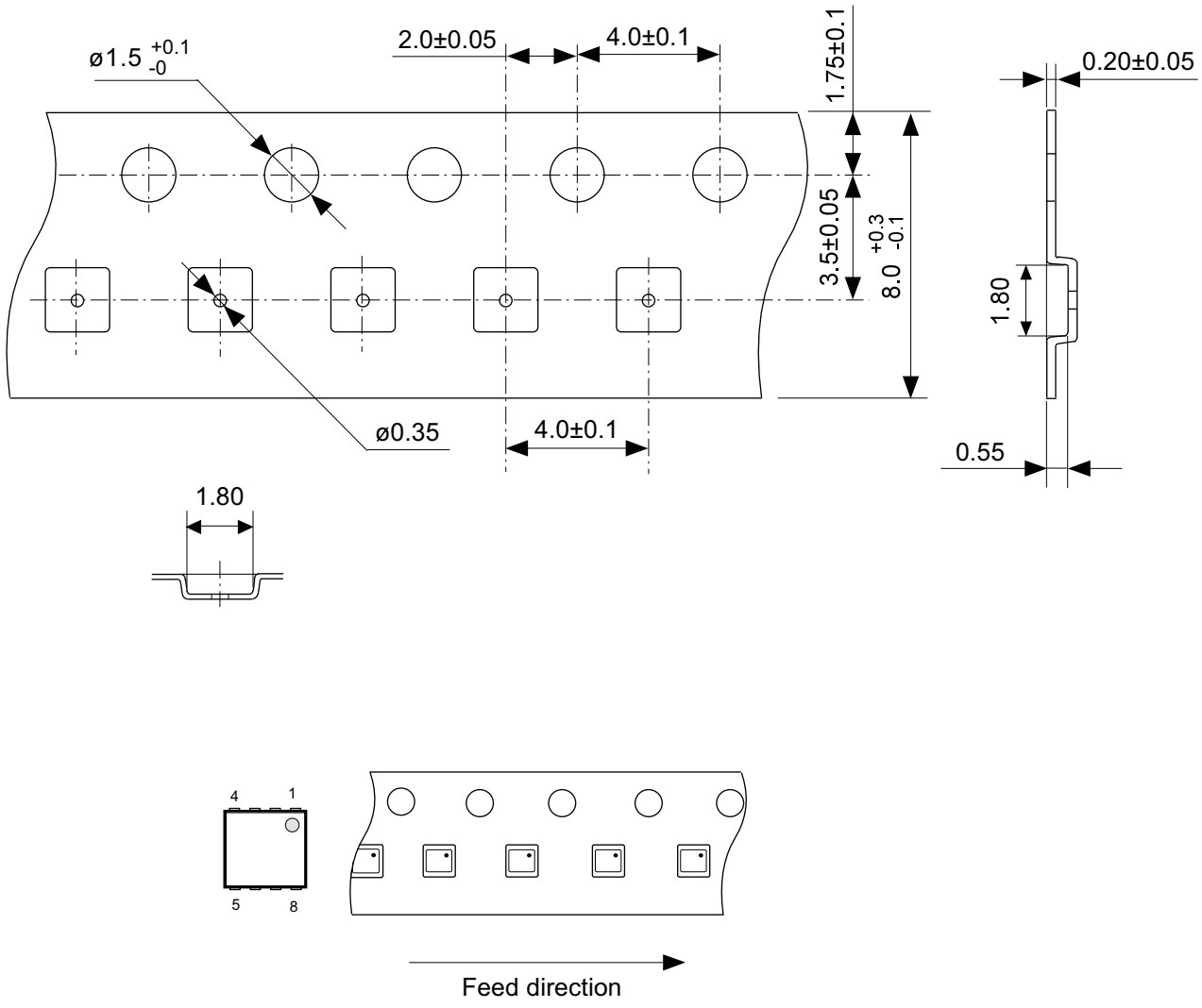




※ The heat sink of back side has different electric potential depending on the product.
Confirm specifications of each product.
Do not use it as the function of electrode.

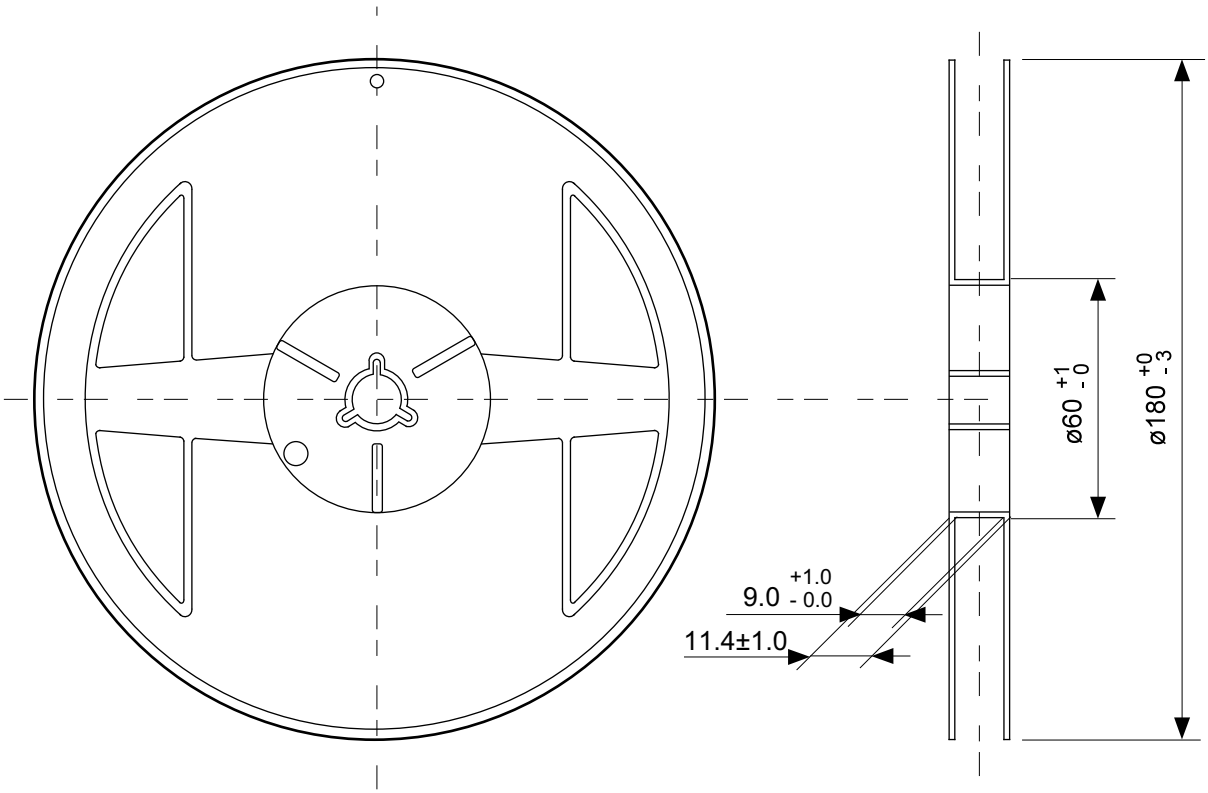
No. PY008-A-P-SD-1.0

TITLE	HSNT-8-B-PKG Dimensions
No.	PY008-A-P-SD-1.0
ANGLE	
UNIT	mm
ABLIC Inc.	

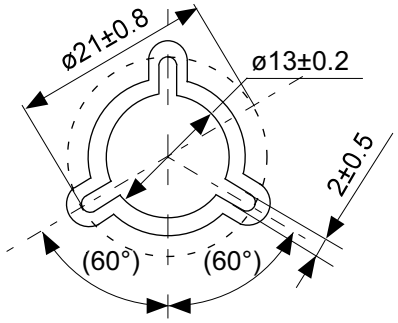


No. PY008-A-C-SD-1.0

TITLE	HSNT-8-B-Carrier Tape
No.	PY008-A-C-SD-1.0
ANGLE	
UNIT	mm
ABLIC Inc.	



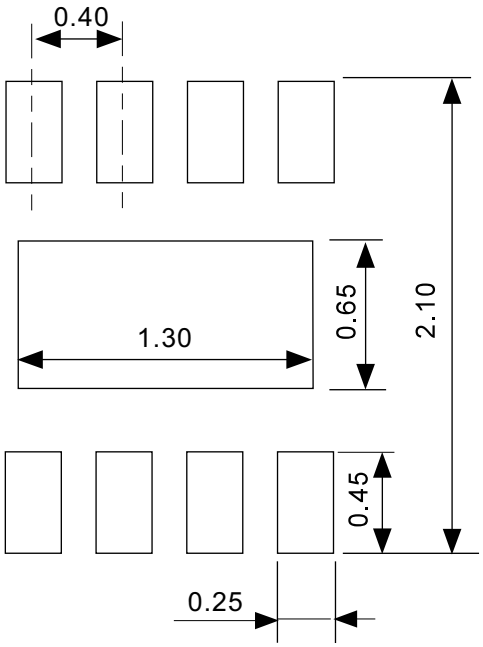
Enlarged drawing in the central part



No. PY008-A-R-SD-1.0

TITLE	HSNT-8-B-Reel		
No.	PY008-A-R-SD-1.0		
ANGLE		QTY.	5,000
UNIT	mm		
ABLIC Inc.			

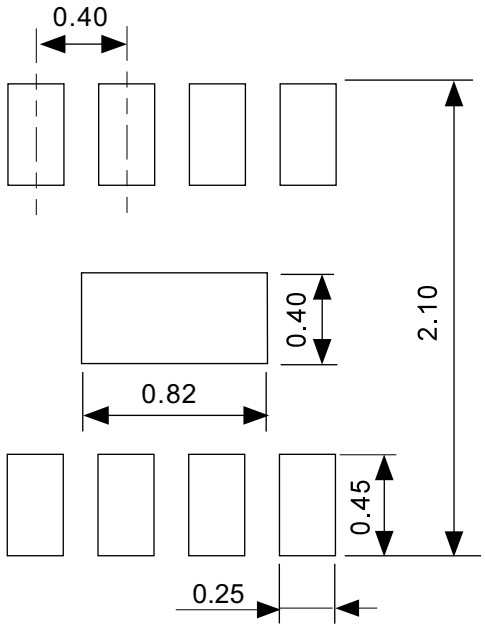
Land Pattern



Caution It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

注意 放熱性を確保する為に、PKGの裏面放熱板(ヒートシンク)を基板に半田付けする事を推奨いたします。

Metal Mask Pattern



Caution ① Mask aperture ratio of the lead mounting part is 100%.
② Mask aperture ratio of the heat sink mounting part is 40%.
③ Mask thickness: t0.12 mm

注意 ①リード実装部のマスク開口率は100%です。
②放熱板実装のマスク開口率は40%です。
③マスク厚み：t0.12 mm

No. PY008-A-L-SD-1.0

TITLE	HSNT-8-B -Land Recommendation
No.	PY008-A-L-SD-1.0
ANGLE	
UNIT	mm
ABLIC Inc.	

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2.4-2019.07